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Construction Techniques

Home construction of electronics projects and kits can be a fun part of Amateur Radio. Some say that hams don't build things nowadays; this just isn't so! A recent ARRL survey shows that more than half of active hams build some electronic projects. When you go to any ham flea market, you see row after row of dealers selling electronic components; people are leaving those tables with bags of parts. They must be doing something with them! Even experienced constructors will find valuable tips in this chapter. It discusses tools and their uses, electronic construction techniques, tells how to turn a schematic into a working circuit and then summarizes common mechanical construction practices. This chapter has been updated by Joe Eisenberg, KØNEB from material originally written and compiled by Ed Hare, W1RFI, and Jim Duffey, KK6MC.

Chapter 23 — CD-ROM Content



Supplemental Files

- “A No-Special-Tools SMD Desoldering Technique” by Wayne Yoshida, KH6WZ
- “Surface Mount Technology — You Can Work With It” by Sam Ulbing, N4UAU (Parts 1 - 4)
- “A Deluxe Soldering Station”
- Making Your Own Printed Circuit Boards
- “Reflow Soldering for the Radio Amateur” by Jim Koehler, VE5JP

23.1 Electronic Shop Safety

Building, repairing and modifying equipment in home workshops is a longstanding ham radio tradition. In fact, in the early days, building your own equipment was the only option available. While times and interests change, home construction of radio equipment and related accessories remains popular and enjoyable. Building your own gear need not be hazardous if you become familiar with the hazards, learn how to perform the necessary functions and follow some basic safe practices including the ones listed below and in the section on soldering. Let's start with our own abilities:

Consider your state of mind. Working on projects or troubleshooting (especially where high voltage is present) requires concentration. Don't work when you're tired or distracted. Be realistic about your ability to focus on the job at hand. Put another way, if we aren't able to be highly alert, we should put off doing hazardous work until we are able to focus on the hazards.

Think! Pay attention to what you are doing. No list of safety rules can cover all possibilities. Safety is always your responsibility. You must think about what you are doing, how it relates to the tools and the specific situation at hand. When working with tools, avoid creating situations in which you can be injured or the project damaged if things don't go “just right.”

Take your time. If you hurry, not only will you make more mistakes and possibly spoil the appearance of your new equipment, you won't have time to think things through. Always plan ahead. Do not work with shop tools if you can't concentrate on what you are doing — it's not a race! Working when you are tired can also lead to problems, such as misidentification of parts or making poor or erroneous connections. Listening to the regular time notices on broadcast radio while you work will prompt you to take plenty of breaks so you do not work when you are too tired.

Protect yourself. Use of drills, saws, grinders and other wood- or metal-working equipment can release small fragments that could cause serious eye damage. Always wear safety glasses or goggles when doing work that might present a flying object hazard and that includes soldering, where small bits of molten solder can be flung a surprising distance. If you use hammers, wire-cutters, chisels and other hand tools, you will also need the protection that safety eyewear offers. Dress appropriately — loose clothing (or even hair) can be caught in exposed rotating equipment such as drill presses.

Don't work alone. Have someone nearby who can help if you get into trouble when working with dangerous equipment, chemicals or voltages.

Know what to do in an emergency. Despite your best efforts to be careful, accidents may still occur from time to time. Ensure that everyone in your household knows basic first aid procedures and understands how to summon help in an emergency. They should also know where to find and how to safely shut down electrical power in your shack and shop. Get medical help when necessary. Every workshop should contain a good first-aid kit. Keep an eye-wash kit near any dangerous chemicals or power tools that can create chips or splinters. If you become injured, apply first aid and then seek medical help if you are not sure that you are okay. Even a small burn or scratch on your eye can develop into a serious problem if not treated promptly.

What about the equipment and tools involved in shop work? Here are some basic safety considerations that apply to them, as well:

Table 23.1
Properties and Hazards of Chemicals often Used in the Shack or Workshop

<i>Generic Chemical Name</i>	<i>Purpose or Use</i>	<i>Hazards</i>	<i>Ways to Minimize Risks</i>
Lead-tin solder	Bonding electrical components	Lead exposure (mostly from hand contact) Flux exposure (inhalation)	Always wash hands after soldering or touching solder. Use good ventilation.
Isopropyl alcohol	Flux remover	Dermatitis (skin rash) Vapor inhalation Fire hazard	Wear molded gloves suitable for solvents. Use good ventilation and avoid aerosol generation. Use good ventilation, limit use to small amounts, keep ignition sources away, dispose of rags only in tightly sealed metal cans.
Freons	Circuit cooling and general solvent	Vapor inhalation Dermatitis	Use adequate ventilation. Wear molded gloves suitable for solvents.
Phenols and methylene chloride	Enameled wire/ paint stripper	Strong skin corrosive	Avoid skin contact; wear suitable molded gloves; use adequate ventilation.
Beryllium oxide	Ceramic insulator found in some power transistors and vacuum tubes that conducts heat well	Toxic when in fine dust form and inhaled	Avoid grinding, sawing or reducing to dust form.
Beryllium metal	Lightweight metal, alloyed with copper	Same as beryllium oxide	Avoid grinding, sawing, welding or reducing to dust. Contact supplier for special procedures.
Various paints	Finishing	Exposures to solvents Exposures to sensitizers (especially urethane paint) Exposure to toxic metals (lead, cadmium, chrome, and so on) in pigments Fire hazard (especially when spray painting)	Adequate ventilation; use respirator when spraying. Adequate ventilation and use respirator. Adequate ventilation and use respirator. Adequate ventilation; control of residues; eliminate ignition sources.
Ferric chloride	Printed circuit board etchant	Skin and eye contact	Use suitable containers; wear splash goggles and molded gloves suitable for acids.
Ammonium persulfate and mercuric chloride	Printed circuit board etchants	Skin and eye contact	Use suitable containers; wear splash goggles and molded gloves suitable for acids.
Epoxy resins	General purpose cement or paint	Dermatitis and possible sensitizer	Avoid skin contact. Mix only amount needed.
Sulfuric acid	Electrolyte in lead-acid batteries	Strong corrosive when on skin or eyes. Will release hydrogen when charging (fire, explosion hazard).	Always wear splash goggles and molded plastic gloves (PVC) when handling. Keep ignition sources away from battery when charging. Use adequate ventilation.

Read instructions and manuals carefully... and follow them. The manufacturers of tools are the most knowledgeable about how to use their products safely. Tap their knowledge by carefully reading all operating instructions and warnings. Avoiding injuries with power tools requires safe tool design as well

as proper operation by the user. Keep the instructions in a place where you can refer to them in the future.

Respect safety features of the equipment you work on and use. Never disable any safety feature of any tool. If you do, sooner or later you or someone else will make the mistake

the safety feature was designed to prevent.

Keep your shop or work area neat and organized. A messy shop is a dangerous shop. A knife left laying in a drawer can cut someone looking for another tool; a hammer left on top of a shelf can fall down at the worst possible moment; a sharp tool left on a chair can be a

dangerous surprise for the weary constructor who sits down.

Keep your tools in good condition. Always take care of your investment. Store tools in a way to prevent damage or use by untrained persons (young children, for example). Keep the cutting edges of saws, chisels and drill bits sharp. Protect metal surfaces from corrosion. Frequently inspect the cords and plugs of electrical equipment and make any necessary repairs. If you find that your power cord is becoming frayed, repair it right away. One solution is to buy a replacement cord with a molded connector already attached.

Make sure your shop is well ventilated. Paint, solvents, cleaners or other chemicals can create dangerous fumes. If you feel dizzy, get into fresh air immediately, and seek medical help if you do not recover quickly.

Respect power tools. Power tools are not forgiving. A drill can go through your hand a lot easier than metal. A power saw can remove a finger with ease. Keep away from the business end of power tools. Tuck in your shirt, roll up your sleeves and remove your tie before using any power tool. If you have long hair, tie it back so it can't become entangled in power equipment.

23.1.1 Chemicals

Chemicals such as cleaners, adhesives, construction materials, and coolants are used every day by amateurs without ill effects. Take the opportunity to become knowledgeable of the hazards associated with these materials and treat them with respect. **Table 23.1** summarizes the uses and hazards of chemicals and other materials used in the ham shack. It includes preventive measures that can minimize risk. For advanced infor-

Poison Control

If you think you have a chemical emergency, call your local poison control center immediately. Dial 1-800-222-1222 or use the map at www.poison.org/otherPC to find the center in your area or dial 911.

mation, the Centers for Disease Prevention and Control maintains an extensive database at www.cdc.gov/niosh/topics/chemical-safety. Meridian Engineering maintains a collection of materials safety information at www.meridianeng.com/datasheets.html. When in doubt, contact the manufacturer or distributor of the material for safety information or use an Internet search engine by entering the material name and "safety" into the search window.

Here are a few key suggestions for safely storing, handling, and using chemicals:

Read the information that accompanies the chemical and follow the manufacturer's recommended safety practices. If you would like more information than is printed on the label, ask for a material safety data sheet (MSDS). Manufacturers of brand-name chemical products usually post an MSDS on their product websites.

Store chemicals properly, away from sunlight and sources of heat. Secure their containers to prevent spills and so that children and untrained persons will not gain access. Always keep containers labeled so there is no confusion about the contents. It is best to use the container in which the chemical was purchased. If you transfer solvents to other

containers, such as wash bottles, label the new container with exactly what it contains.

Handle chemicals carefully to avoid spills. Clean up any spills or leaks promptly but don't overexpose yourself in the process. Never dispose of chemicals in household sinks or drains. Instead, contact your local waste plant operator, transfer station or fire department to determine the proper disposal procedures for your area. Many communities have household hazardous waste collection programs. Of course, the best solution is to only buy the amount of chemical that you will need, and use it all if possible. Always label any waste chemicals, especially if they are no longer in their original containers. Oil-filled capacitors and transformers were once commonly filled with oil containing PCBs. Never dispose of any such items that may contain PCBs in landfills – contact your county or city recycling office or local electric utility for information on proper disposal.

Always use recommended personal protective equipment (such as gloves, face shield, splash goggles and aprons). If corrosives (acids or caustics) are splashed on you *immediately* rinse with cold water for a minimum of 15 minutes to flush the skin thoroughly. If splashed in the eyes, direct a gentle stream of cold water into the eyes for at least 15 minutes. Gently lift the eyelids so trapped liquids can be flushed completely. Start flushing before removing contaminated clothing. Seek professional medical assistance. If using hazardous chemicals, it is unwise to work alone since people splashed with chemicals need the calm influence of another person.

Food and chemicals don't mix. Keep food, drinks and cigarettes *away* from areas where chemicals are used and don't bring chemicals to places where you eat.

23.2 Tools and Their Use

All electronic construction makes use of tools, from mechanical tools for chassis fabrication to the soldering tools used for circuit assembly. A good understanding of tools and their uses will enable you to perform most construction tasks.

While sophisticated and expensive tools often work better or more quickly than simple hand tools, with proper use, simple hand tools can turn out a fine piece of equipment. **Table 23.2** lists tools indispensable for construction of electronic equipment. These tools can be used to perform nearly any construction task. Add tools to your collection from time to time, as finances permit.

23.2.1 Sources of Tools

Electronic-supply houses, mail-order/web stores and most hardware stores carry the tools required to build or service Amateur Radio equipment. Bargains are available at ham flea markets or local neighborhood sales, but beware! Some flea-market bargains are really shoddy and won't work very well or last very long. Some used tools are offered for sale because the owner is not happy with their performance.

There is no substitute for quality! A high-quality tool, while a bit more expensive, will last a lifetime. Poor quality tools don't last long and often do a poor job even when brand

new. You don't need to buy machinist-grade tools, but stay away from cheap tools; they are not the bargains they might appear to be.

CARE OF TOOLS

The proper care of tools is more than a matter of pride. Tools that have not been cared for properly will not last long or work well. Dull or broken tools can be safety hazards. Tools that are in good condition do the work for you; tools that are misused or dull are difficult to use.

Store tools in a dry place. Tools do not fit in with most living room decors, so they are often relegated to the basement or garage.

Table 23.2
Recommended Tools and Materials

Simple Hand Tools

Screwdrivers

Slotted, 3-in, 1/8-in blade
Slotted, 8-in, 1/8-in blade
Slotted, 3-in, 3/16-in blade
Slotted, stubby, 1/4-in blade
Slotted, 4-in, 1/4-in blade
Slotted, 6-in, 5/16-in blade
Phillips, 2 1/2-in, #0 (pocket clip)
Phillips, 3-in, #1
Phillips, stubby, #2
Phillips, 4-in, #2
Long-shank screwdriver with holding clip on blade
Jeweler's set
Right-angle, slotted and Phillips

Pliers, Sockets and Wrenches

Long-nose pliers, 6- and 4-in
Diagonal cutters, 6- and 4-in
Channel-lock pliers, 6-in
Slip-joint pliers
Locking pliers (Vise Grip or equivalent)
Socket nut-driver set, 1/16- to 1/2-in
Set of socket wrenches for hex nuts
Allen (hex) wrench set
Wrench set
Adjustable wrenches, 6- and 10-in
Tweezers, regular and reverse-action
Retrieval tool/parts holder, flexible claw
Retrieval tool, magnetic

Cutting and Grinding Tools

File set consisting of flat, round, half-round, and triangular. Large and miniature types recommended
Burnishing tool
Wire strippers
Wire crimper
Hemostat, straight
Scissors
Tin shears, 10-in
Hacksaw and blades
Hand nibbling tool (for chassis-hole cutting)

Scratch awl or scribe (for marking metal)
Heavy-duty jackknife
Knife blade set (X-ACTO or equivalent)
Machine-screw taps, #4-40 through #10-32 thread
Socket punches, 1/2 in, 5/8 in, 3/4 in, 1 1/8 in, 1 1/4 in, and 1 1/2 in
Tapered reamer, T-handle, 1/2-in maximum width
Deburring tool

Miscellaneous Hand Tools

Combination square, 12-in, for layout work
Hammer, ball-peen, 12-oz head
Hammer, tack
Bench vise, 4-in jaws or larger
Center punch
Plastic alignment tools
Mirror, inspection
Flashlight, penlight and standard
Magnifying glass
Ruler or tape measure
Dental pick
Calipers
Brush, wire
Brush, soft
Small paintbrush
IC-puller tool

Hand-Powered Tools

Hand drill, 1/4-in chuck or larger
High-speed drill bits, #60 through 3/8-in diameter

Power Tools

Motor-driven emery wheel for grinding
Electric drill, hand-held
Drill press
Miniature electric motor tool (Dremel or equivalent) and accessory drill press

Soldering Tools and Supplies

Soldering station, adjustable temp, assorted tips
Soldering iron, 100 W or higher, 5/8-in tip

Soldering gun, 200 W or higher
Solder, 60/40, rosin core
Desoldering tool
Desoldering wick, 1/8-in and 1/4-in width
Liquid flux, pen or bottle
Isopropyl alcohol for flux removal

Safety

Safety glasses
Hearing protector, earphones or earplugs
Fire extinguisher
First-aid kit

Useful Materials

Medium-weight machine oil
Contact cleaner, liquid or spray can
RTV sealant or equivalent
Electrical tape, vinyl plastic
Sandpaper, assorted
Emery cloth
Steel wool, assorted
Cleaning pad, Scotchbrite or equivalent
Cleaners and degreasers
Contact lubricant
Sheet aluminum, solid and perforated, 16- or 18-gauge, for brackets and shielding.
Aluminum angle stock, 1/2 x 1/2-in and 1/4-in diameter round brass or aluminum rod (for shaft extensions)
Machine screws: Round-head and flat head, with nuts and lockwashers to fit. Most useful sizes: 4-40, 6-32 and 8-32, in lengths from 1/4-in to 1 1/2 in (Nickel-plated steel is satisfactory except in strong RF fields, where brass should be used.)
Bakelite, Lucite, polystyrene and copper-clad PC-board scraps.
Soldering lugs, panel bearings, rubber grommets, terminal-lug wiring strips, varnished-cambric insulating tubing, heat-shrinkable tubing
Shielded and unshielded wire
Tinned bare wire, #22, #14 and #12
Enameled wire, #20 through #30

Unfortunately, many basements or garages are not good places to store tools; dampness and dust are not good for tools. If your tools are stored in a damp place, use a dehumidifier. Sometimes you can minimize rust by keeping your tools lightly oiled, but this is a second-best solution. If you oil your tools, they may not rust, but you will end up covered in oil every time you use them. Wax or silicone spray is a better alternative.

Store tools neatly. A messy toolbox, with tools strewn about haphazardly, can be more than an inconvenience. You may waste a lot of time looking for the right tool and sharp edges can be dulled or nicked by tools banging into each other in the bottom of the box. As the old adage says, every tool should have a place, and every tool should be in its place. If you must search the workbench, garage, attic and car to find the right screwdriver,

you'll spend more time looking for tools than building projects.

SHARPENING

Many cutting tools can be sharpened. Send a tool that has been seriously dulled to a professional sharpening service. These services can sharpen saw blades, some files, drill bits and most cutting blades. Touch up the edge of cutting tools with a whetstone to extend the time between sharpening.

Sharpen drill bits frequently to minimize the amount of material that must be removed each time. Frequent sharpening also makes it easier to maintain the critical surface angles required for best cutting with least wear. Most inexpensive drill-bit sharpeners available for shop use do a poor job, either from the poor quality of the sharpening tool or inexperience of the operator. Also, drills should be sharp-

ened at different angles for different applications. Commercial sharpening services do a much better job.

INTENDED PURPOSE

Don't use tools for anything other than their intended purpose! If you use a pair of wire cutters to cut sheet metal, pliers as a vise or a screwdriver as a pry bar, you ruin a good tool and sometimes the work piece, as well. Although an experienced constructor can improvise with tools, most take pride in not abusing them. Having a wide variety of good tools at your disposal minimizes the problem of using the wrong tool for the job.

23.2.2 Tool Descriptions and Uses

Specific applications for tools are dis-

cussed throughout this chapter. Hand tools are used for so many different applications that they are discussed first, followed by some tips for proper use of power tools.

SCREWDRIVERS AND NUTDRIVERS

For construction or repair, you need to have an assortment of screwdrivers. Each blade size is designed to fit a specific range of screw head sizes. Using the wrong size blade usually damages the blade, the screw head or both. You may also need stubby sizes to fit into tight spaces. Right-angle screwdrivers are inexpensive and can get into tight spaces that can't otherwise be reached.

Electric screwdrivers are relatively inexpensive and very useful, particularly for repetitive tasks. If you have a lot of screws to fasten, they can save a lot of time and effort. They come with a wide assortment of screwdriver and nutdriver bits. An electric drill can also function as an electric screwdriver, although it may be heavy and over-powered for many applications.

Keep screwdriver blades in good condition. If a blade becomes broken or worn out, replace the screwdriver. A screwdriver only costs a few dollars; do not use one that is not in perfect condition. Save old screwdrivers to use as pry bars and levers, but use only good ones on screws. Filing a worn blade seldom gives good results.

Nutdrivers, the complement to screwdrivers, are often much easier to use than a wrench, particularly for nuts smaller than $\frac{3}{8}$ inch. They are also less damaging to the nut than any type of pliers, with a better grip on the nut. Nutdrivers also minimize the chances of damage to front panels when tightening the nuts on control shafts. A set of interchangeable nutdrivers with a shared handle is a very handy addition to the toolbox.

PLIERS AND LOCKING-GRIP PLIERS

Pliers and locking-grip pliers are used to hold or bend things. They are not wrenches! If pliers are used to remove a nut or bolt, the nut or the pliers is usually damaged. To remove a nut, use a wrench or nutdriver. There is one exception to this rule of thumb: To remove a nut that is stripped too badly for a wrench, use a pair of pliers, locking-grip pliers, or a diagonal cutter to bite into the nut and start it turning. Reserve an old tool or one dedicated to just this purpose as it is not good for the tool.

Pliers are not intended for heavy-duty applications. Use a metal brake to bend heavy metal; use a vise to hold a heavy component. If the pliers' jaws or teeth become worn, replace the tool.

There are many different kinds of fine pliers, usually called "needle-nose" pliers or something similar, that are particularly useful

in electronics work. These are intended for light jobs, such as bending or holding wires or small work pieces. Two or three of these tools with different sizes of jaws will suffice for most jobs.

WIRE CUTTERS AND STRIPPERS

Wire cutters are primarily used to cut wires or component leads. The choice of blade style depends on the application. Diagonal blades or "dikes" are most often used to cut wire. Some delicate components can be damaged by cutting their leads with dikes because of the abrupt shock of the cut. Scissors or shears designed to cut wire should be used instead.

Specialized wire cutters are available to trim wires leads on circuit boards. These cutters are often called "flush cutters". Their cutting end is *not* designed to cut thicker wires. Use them *only* to clip smaller gauge wires, such as that on components used in circuits.

Wire strippers are available in manual and automatic styles. The manual strippers have a series of holes designed to remove insulation from a specific gauge of wire. Using the holes that are too big or too small will create nicks in the wire, which usually leads to the wire breaking at the nick. Automatic strippers grab and hold the wire for a consistent strip — some even judge the wire thickness automatically. If you strip a lot of wires, an automatic stripper may be worth the extra expense.

Wire strippers are handy, but with a little practice you can usually strip wires using a diagonal cutter or a knife. This is not the only use for a knife, so keep an assortment handy. Do not use wire cutters or strippers on anything other than wire! If you use a cutter to trim a protruding screw head or cut a hardened-steel spring, you will usually damage the blades.

FILES

Files are used for a wide range of tasks. In addition to enlarging holes and slots, they are used to remove burrs, shape metal, wood or plastic and clean some surfaces in preparation for soldering. Files are especially prone to damage from rust and moisture. Keep them in a dry place. The cutting edge of the blades can also become clogged with the material you are removing. Use file brushes (also called file cards) to keep files clean. Most files cannot be sharpened easily, so when the teeth become worn, the file must be replaced.

DRILL BITS

Drill bits are made from carbon steel, high-speed steel or carbide. Carbon steel is more common and is usually supplied unless a specific request is made for high-speed bits. Carbon steel drill bits cost less than high-speed or carbide types; they are sufficient for most

Table 23.3
Numbered Drill Sizes

No.	Diameter (Mils)	Will Clear Screw	Drilled for Tapping from Steel or Brass
1	228.0	12-24	—
2	221.0	—	—
3	213.0	—	14-24
4	209.0	12-20	—
5	205.0	—	—
6	204.0	—	—
7	201.0	—	—
8	199.0	—	—
9	196.0	—	—
10	193.5	—	—
11	191.0	10-24 10-32	—
12	189.0	—	—
13	185.0	—	—
14	182.0	—	—
15	180.0	—	—
16	177.0	—	12-24
17	173.0	—	—
18	169.5	—	—
19	166.0	8-32	12-20
20	161.0	—	—
21	159.0	—	10-32
22	157.0	—	—
23	154.0	—	—
24	152.0	—	—
25	149.5	—	10-24
26	147.0	—	—
27	144.0	—	—
28	140.0	6-32	—
29	136.0	—	8-32
30	128.5	—	—
31	120.0	—	—
32	116.0	—	—
33	113.0	4-40	—
34	111.0	—	—
35	110.0	—	—
36	106.5	—	6-32
37	104.0	—	—
38	101.5	—	—
39	099.5	3-48	—
40	098.0	—	—
41	096.0	—	—
42	093.5	—	—
43	089.0	—	4-40
44	086.0	2-56	—
45	082.0	—	—
46	081.0	—	—
47	078.5	—	3-48
48	076.0	—	—
49	073.0	—	—
50	070.0	—	2-56
51	067.0	—	—
52	063.5	—	—
53	059.5	—	—
54	055.0	—	—

equipment construction work. Carbide drill bits last much longer under heavy use. One disadvantage of carbide bits is that they are brittle and break easily, especially if you are using a hand-held power drill. When drilling abrasive material, such as fiberglass, the carbide bits last much longer than the steel bits.

Twist drills are available in a number of sizes listed in **Table 23.3**. Those listed in bold

type are the most commonly used in construction of amateur equipment. You may not use all of the drills in a standard set, but it is nice to have a complete set on hand. You should also buy several spares of the more common sizes. Although Table 23.3 lists drills down to #54, the series extends to number #80. While the smaller sizes cannot usually be found in hardware stores or home improvement stores, they are commonly available through industrial tool suppliers and through various sources on the Internet.

A “step drill” consists of multiple drill diameters stacked as one bit, looking somewhat like a Christmas tree. These bits are very useful for drilling metal case material used in radio projects as the fluted edge of the bit in between sizes removes most if not all burrs from the hole you are drilling. Use them carefully and slowly to take advantage of their ability to remove burrs. A step drill also has the advantage of being able to drill a number of different standard size holes without having to change the bit.

SPECIALIZED TOOLS

Most constructors know how to use common tools, such as screwdrivers, wrenches and hammers. Although specialized tools usually do a job that can be done with other tools, once the specialty tool is used you will wonder how you ever did the job without it! Let’s discuss other tools that are not so common.

A hand nibbling tool is shown in **Fig 23.1**. Use this tool to remove small “nibbles” of metal. It is easy to use; position the tool where you want to remove metal and squeeze the handle. The tool takes a small bite out of the metal. When you use a nibbler, be careful that you don’t remove too much metal, clip the edge of a component mounted to the sheet metal or grab a wire that is routed near the edge of a chassis. Fixing a broken wire is easy, but something to avoid if possible. It is easy to remove metal but nearly impossible to put it back. Do it right the first time!

Deburring Tool

A deburring tool is just the thing to remove the sharp edges left on a hole after drilling or punching operations. See **Fig 23.2**. Position the tool over the hole and rotate it around the edge of the hole to remove burrs or rough edges. As an alternative, select a drill bit that is somewhat larger than the hole, position it over the hole, and spin it lightly to remove the burr. Be sure to deburr both sides of the hole.

Socket or Chassis Punches

Greenlee is the most widely known of the

socket-punch manufacturers. Most socket punches are round, but they do come in other shapes. To use one, drill a pilot hole large enough to clear the bolt that runs through the punch. Then, mount the punch as shown in **Fig 23.3**, with the cutter on one side of the sheet metal and the socket on the other.



Fig 23.1 — A nibbling tool is used to remove small sections of sheet metal.



Fig 23.2 — A deburring tool is used to remove the burrs left after drilling a hole.



Fig 23.3 — A socket punch is used to punch a clean, round hole in sheet metal.

Tighten the nut with a wrench until the cutter cuts all the way through the sheet metal. These punches are often sold in sets at a significant discount to the same punches purchased separately. Hand-punches that operate by squeezing will also cut small holes by hand in light-gauge sheet metal, printed-circuit boards, and plastic.

Crimping Tools

The use of crimped connectors is common in the electronics industry. In many commercial and aerospace applications, soldered joints are no longer used. Hams have been reluctant to adapt crimped connections, largely due to mistrust of contacts that are not soldered, the use of cheap crimp connectors on consumer electronics, and the high cost of quality crimping tools or “crimpers.” If high quality connectors and tools are used, the crimped connector will be as reliable a connection as a soldered one. The crimped connection is easier to make than a soldered one in most cases.

Crimped coaxial connectors are the most common crimped connector. MIL-spec or equivalent crimp connectors are available for the UHF, BNC, F and N-series MIL-spec connectors. Power connectors, such as the Anderson PowerPoles and Molex connectors are probably the second most commonly used crimped connections.

When purchasing a crimper, look for a ratcheting model with dies that are intended for the connectors you will be using. The common pliers-type crimper designed for household electrical terminals will have trouble crimping power connectors and is unsuitable for coaxial connectors. A good ratcheting crimper can be obtained for \$50 to \$100 with the necessary interchangeable dies. Large ratcheting crimpers suitable for the larger coaxial connectors can cost several hundred dollars. A good crimper and set of dies is an excellent investment for a club or group of like-minded hams.

Useful Shop Materials

Small stocks of various materials are used when constructing electronics equipment. Most of these are available from hardware or radio supply stores. A representative list is shown at the end of Table 23.2.

Small parts, such as machine screws, nuts, washers and soldering lugs can be economically purchased in large quantities (it doesn’t pay to buy more than a lifetime supply). For items you don’t use often, many radio supply stores or hardware stores sell small quantities and assortments. Stainless steel hardware can be kept on hand for outdoor use.

23.3 Soldering Tools and Techniques

Soldering is used in nearly every phase of electronic construction so you'll need soldering tools. This section discusses the tools and materials used in soldering.

23.3.1 Soldering Irons

A soldering tool must be hot enough to do the job and lightweight enough for agility and comfort. A heavy soldering gun useful for assembling wire antennas is too large for printed-circuit work, for example. A fine-tip soldering iron (sometimes called a "soldering pencil") works well for smaller jobs.

You may need an assortment of soldering irons to do a wide variety of soldering tasks. They range in size from a small 25 W iron for delicate printed-circuit work to larger 100 to 300 W soldering irons and guns. Small "pencil" butane-powered soldering irons and torches are also available, with a variety of soldering-iron tips. Most butane irons are not suited to use over long periods of time, but are ideal for small jobs and for performing tasks suited for a larger soldering iron, as they can be turned up to relatively high heating levels. Most small butane pencil irons can be set to provide as little as 10 W of equivalent heat, or up to 75-100 W. Butane powered irons also perform well outdoors, making them ideal for antenna work. Battery powered irons are available too, but are also not suited for use over long periods.

A 25 W pencil tip iron is adequate for printed circuit board work. A 40 W iron is necessary for larger jobs, such as soldering leads to panel connectors and making splices. These two irons or a temperature-controlled soldering station should handle most electronic homebrew requirements. A 100 W iron is good for bigger jobs, such as soldering antenna connections or soldering to power cables.

You should get several different sizes and shapes of tips when you purchase an iron. While most people prefer a conical tip, the chisel tip is also useful. The lower wattage irons will likely have a good selection of tip sizes and geometries. Irons 100 W and larger usually have a non-interchangeable chisel tip. For printed circuit board work, a good rule of thumb is to use a tip whose point is the same size as the component leads you are soldering.

If you buy an iron for use on circuits that contain electrostatic sensitive components, get one that has a grounded tip. Otherwise, you risk electrostatic damage to the components. Such irons are usually specified as having a grounded tip, and will have a three-prong plug. It is usually not necessary to have a grounded tip on the 100 W iron as it is not used on sensitive components.

Soldering guns are used for larger jobs and are too large for most electronics work. Where the soldering iron tip has an internal heater, the soldering gun tip is heated directly by current flowing in the tip. The nuts connecting the tip to the iron can loosen with each heat cycle, so they need tightening periodically. Soldering guns are available that have high and low heat levels controlled by an extra trigger position. Soldering gun tips are usually copper and do not last as long as the iron-clad tips of the smaller irons.

If you do a lot of building, a *soldering station* with a temperature-controlled tip is a better investment than a simple iron. The iron tip temperature can be precisely controlled and can be varied to the type of work being done. Soldering stations generally reach operating temperature more quickly than conventional irons and can be turned down to idle when you are not soldering. Some even have a digital tip temperature display. Soldering stations are available from numerous manufacturers. It is best to buy from an established manufacturer to insure future availability of tips and other components. Reconditioned soldering stations are often available and are good value.

If the only available soldering iron is a simple pencil type iron, an inexpensive means to vary the temperature of the iron is to use a lamp dimmer. A simple control box can be made from a dimmer, wall socket, power cord, and outlet box available at any hardware store. Since a simple soldering iron is a resistive load, a lamp dimmer designed to work with incandescent lamps works well to cool down a soldering iron, and warm it up quickly once it is needed. This allows you to turn down the temperature of the iron while it is idle to prevent oxidation of the tip if left at full heat without being used.

RF-heated irons and hot-air soldering tools are primarily in use by industry and particularly useful for soldering surface-mount devices. The cost of these stations is high, although they are available as used and reconditioned.

MAINTAINING SOLDERING IRONS

Keep soldering tools in good condition by keeping the tips well-tinned with solder. Tinning is performed by melting solder directly onto the tip and letting it form a coating. Do not keep the tips at full temperature for long periods when not in use.

After each use, remove the tip and clean off any scale that may have accumulated. Clean an oxidized tip by dipping the hot tip in sal ammoniac (ammonium chloride) and then wiping it clean with a rag. Sal ammoniac is somewhat corrosive, so if you don't wipe the tip thoroughly, it can contaminate electronic

soldering. There are proprietary "tip tinner" products available that can also be used for this function.

If a tip becomes oxidized during use, it can be restored to its shiny state by wiping the tip with a damp sponge or rag and then re-tinning. (Some tips are not supposed to be cleaned with water — check the manufacturer's recommendations.) A gentle scraping is also useful for stubborn cases. A copper or stainless-steel coil kitchen scrubber (do not use a scrubber that contains soap) works fine for this. Swipe the iron through the scrubber to clean it. A scrubber or sponge is most conveniently used by cramming it into a clean tuna can and placing it next to the solder station.

If a copper tip becomes pitted after repeated use, file it smooth and bright and then tin it immediately with solder. The solder prevents further oxidation of the tip. Modern soldering iron tips are nickel or iron clad and should not be filed, as the cladding protects the tip from pitting.

The secret of good soldering is to use the right amount of heat. Many people who have not soldered before use too little heat, dabbing at the joint to be soldered and making little solder blobs that cause unintended short circuits.

On a printed circuit board, examine your connections closely. If it looks like a rounded blob, reheat it with your soldering iron tip, drawing the tip away from the connection along the wire lead, forming a desired "Hershey's Kiss" type of appearance. A round blob will often hold the wire in place, but often makes little or no contact with the printed trace on the board's surface.

23.3.2 Solder

Solders have different melting points, depending on the ratio of tin to lead. Tin melts at 450 °F and lead at 621 °F. Solder made from 63% tin and 37% lead melts at 361 °F, the lowest melting point for a tin and lead mixture. Called 63-37 (or eutectic), this type of solder also provides the most rapid solid-to-liquid transition and the best stress resistance.

Solders made with different lead/tin ratios have a plastic state at some temperatures. If the solder is deformed while it is in the plastic state, the deformation remains when the solder freezes into the solid state. Any stress or motion applied to "plastic solder" causes a poor solder joint.

60-40 solder has the best wetting qualities. Wetting is the ability to spread rapidly, coat the surfaces to be joined, and bond materials uniformly. 60-40 solder also has a low melting point. These factors make it the most commonly used solder in electronics.

Some connections that carry high current can't be made with ordinary tin-lead solder because the heat generated by the current would melt the solder. Automotive starter brushes and transmitter tank circuits are two examples. Silver-bearing solders have higher melting points, and so prevent this problem. High-temperature silver alloys become liquid in the 1100 °F to 1200 °F range, and a silver-manganese (85-15) alloy requires almost 1800 °F.

Because silver dissolves easily in tin, tin-bearing solders can leach silver plating from components. This problem can be greatly reduced by partially saturating the tin in the solder with silver or by eliminating the tin. Commercial solders are available which incorporate these features. Tin-silver or tin-lead-silver alloys become liquid at temperatures from 430 °F for 96.5-3.5 (tin-silver), to 588 °F for 1.0-97.5-1.5 (tin-lead-silver). A 15.0-80.0-5.0 alloy of lead-indium-silver melts at 314 °F.

Rosin-core wire-type solder is formed into a tube with a flux compound inside. The resin (usually called "rosin" in solder) in a solder is a *flux*. Flux melts at a lower temperature than solder, so it flows out onto the joint before the solder melts to coat the joint surfaces. The solder used for surface-mount soldering (discussed later) is a cream or paste and flux, if used, must be added to the joint separately.

Flux removes oxide by suspending it in solution and floating it to the top. Flux is not a cleaning agent! Always clean the surfaces to be soldered before soldering. Flux is not a part of a soldered connection — it merely aids the soldering process.

After soldering, remove any remaining flux. Rosin flux can be removed with isopropyl or denatured alcohol. A cotton swab is a good tool for applying the alcohol and scrubbing the excess flux away. Commercial flux-removal sprays are available at most electronic-part distributors. Water-soluble fluxes are also available.

Never use acid flux or acid-core solder for electrical work. It should be used only for plumbing or chassis work. If used on electronics, the flux will corrode and damage the equipment. For circuit construction, only use fluxes or solder-flux combinations that are labeled for electronic soldering.

A basic tutorial on "Soldering 101" including a video demonstration is available from Sparkfun Electronics at www.sparkfun.com/tutorials/213.

LEAD-FREE SOLDER

In 2006, the European Union Restriction of Hazardous Substances Directive (RoHS) went into effect. This directive prohibits manufacture and import of consumer electronics which incorporate lead, including the common tin-lead solder used in electronic as-

sembly. California recently enacted a similar RoHS law. As a result of these directives there has been a move to lead-free solders in commercial use. They can contain two or more elements that are not as hazardous as lead, including tin, copper, silver, bismuth, indium, zinc, antimony and traces of other metals. Two lead-free solders commonly used for electronic use are SnAgCu alloy SAC305 and tin-copper alloy Sn100. SAC305 contains 96.5% tin, 3% silver, and 0.5% copper and melts at 217 °C. Sn100 contains 99.3% tin, 0.6% copper, as well as traces of nickel and silver and melts at 228 °C. Both of these melting points are higher than the 176 °C melting point of 60-40 and 63-37 lead-bearing solder, but conventional soldering stations will be able to reach the melting points of the new solders easily. Tin-lead solders are still available, but the move away from them by commercial manufacturers will probably lead to the day when they will be unavailable to hams who build their own gear. Be prepared.

The new RoHS solders can be used in much the same manner as conventional solders. The resulting solder joint appears somewhat duller than a conventional solder joint, and the lead-free solders tend to wick higher than the lead-tin solders. Due to the higher heat, it is important that the soldering iron tip be clean, shiny and freshly tinned so that heat is transferred to the joint to be soldered as quickly as possible to avoid excess heating of the parts being soldered. The soldering iron should be set to between 700 °F and 800 °F.

Solder and soldering equipment vendors provide numerous guides to hand soldering with lead-free solders. Weller's "Weller University" online presentation www.elexp.com/tips/Weller_Coping_with_Lead_Free.pdf provides a great deal of detail about how soldering iron tips work with lead-free solder. More information is available from Kester (www.kester.com) in the Knowledge Base under the Hand Soldering link.

Most, if not all, RoHS-compliant components can be soldered with lead-tin solder. If the RoHS part has leads that are tinned or coated with an alloy to make soldering easier, it is necessary to use a hotter iron than would normally be required in lead-tin soldering. A soldering iron tip temperature of 315 °C (600 °F) or greater will be adequate for soldering RoHS parts with lead-tin solder. In contrast, a working tip temperature of 275 °C is generally adequate for working with conventional non-RoHS parts.

23.3.3 Soldering

The two key factors in quality soldering are time and temperature. Rapid heating is desired so that all parts of the joint are made hot enough for the solder to remain molten as it flows over the joint surfaces. Most unsuccessful

solder jobs fail because insufficient heat has been applied. To achieve rapid heating, the soldering iron tip should be hotter than the melting point of solder and large enough that transferring heat to the cooler joint materials occurs quickly. A tip temperature about 100 °F (60 °C) above the solder melting point is right for mounting components on PC boards.

Use solder that is sized appropriately for the job. As the cross section of the solder decreases, so does the amount of heat required to melt it. Diameters from 0.025 to 0.040 inch are good for nearly all circuit wiring. Sensitive and smaller components can be damaged or surfaces re-oxidized if heat is applied for too long a period.

If you are a beginner, you may want to start with one of the numerous "Learn to Solder" kits available from many electronics parts and kit vendors. The kits come with a printed-circuit board, a basic soldering iron, solder, and the components to complete a simple electronics project.

Here's how to make a good solder joint. This description assumes that solder with a flux core is used to solder a typical PC board connection such as an IC pin.

- Prepare the joint. Clean all conductors thoroughly with fine steel wool or a plastic scrubbing pad. Clean the circuit board at the beginning of assembly and individual parts such as resistors and capacitors immediately before soldering. Some parts (such as ICs and surface-mount components) cannot be cleaned easily; don't worry unless they're exceptionally dirty.

- Prepare the tool. It should be hot enough to melt solder applied to its tip quickly (half a second when dry, instantly when wet with solder). Apply a little solder directly to the tip so that the surface is shiny. This process is called "tinning" the tool. The solder coating helps conduct heat from the tip to the joint and prevents the tip from oxidizing.

- Place the tip in contact with one side of the joint. If you can place the tip on the underside of the joint, do so. With the tool below the joint, convection helps transfer heat to the joint.

- Place the solder against the joint directly opposite the soldering tool. It should melt within a second for normal PC connections, within two seconds for most other connections. If it takes longer to melt, there is not enough heat for the job at hand. If you have a variable heat soldering iron, adjust it so that the solder flows quickly for the size of wire and joints you are soldering. Much more heat can damage components and the board.

- Keep the tool against the joint until the solder flows freely throughout the joint. When it flows freely, solder tends to form concave joints called "fillets" between the conductors. With insufficient heat solder does

not flow freely; it forms convex shapes — blobs. Once the solder shape changes from convex to concave, remove the tool from the joint. If a fillet won't form, the joint may need additional cleaning. Look for that "Hershey's Kiss" shape to know if it is done correctly.

- Let the joint cool without movement at room temperature. It usually takes no more than a few seconds. If the joint is moved before it is cool, it may take on a dull, satin or grainy appearance that is characteristic of a "cold" solder joint. Reheat cold joints until the solder flows freely and hold them still until cool.

- When the iron is set aside, or if it loses its shiny appearance, wipe away any dirt with a damp cloth or sponge. If it remains dull after cleaning, tin it again.

Overheating a transistor or diode while soldering can cause permanent damage, although as you get better at soldering, you'll be able to solder very quickly with little risk to the components. If the soldering iron will be applied for longer than a couple of seconds, use a small heat sink when you solder transistors, diodes or components with plastic parts that can melt. Grip the component lead with a pair of needle-nose pliers up close to the unit so that the heat is conducted away (be careful — it is easy to damage delicate component leads). A rubber-band wrapped around the pliers handles will hold the pliers on the wire. A small alligator clip or a flat spring type paper clip also makes a good heat sink.

Mechanical stress can damage components, too. Mount components so there is no appreciable mechanical strain on the leads. Be especially careful with small glass diodes and small disc capacitors as these components are easy to break when forming the leads.

Soldering to hollow pins, such as found on connectors, can be difficult, particularly if the connector has been used previously or has oxidized. Use a suitable small twist drill to clean the inside of the pin and then tin it. While the solder is still melted, clear the surplus solder from each pin with a whipping motion or by blowing through the pin from the inside of the connector. Watch out for flying hot solder — use safety goggles and protect the work surface and your arms and legs! A glass ashtray or small baking dish works great for catching the loose solder. Do not perform this operation near open electronic equipment as the loose solder can easily form short circuits. If the pin surface is plated, file the plating from the pin tip. Then insert the wire and solder it. After soldering, remove excess solder with a file, if necessary.

When soldering to the pins of plastic connectors or other assemblies, heat-sink the pin with needle-nose pliers at the base where it comes in contact with the plastic housing. Do not allow the pin to overheat; it will loosen and become misaligned.

23.3.4 Desoldering

There are times when soldered components need to be removed. The parts may be bad, they may be installed incorrectly, or you may want to remove them for use in another project.

There are several techniques for desoldering. The easiest way is to use a desoldering braid. Desoldering braid is simply fine copper braid, often containing flux. It is available under a wide variety of trade names wherever soldering supplies are sold. A good rule of thumb is to choose a width and thickness of desoldering braid that matches the size of the connection being desoldered.

The soldering braid is placed against the joint to be desoldered. A hot iron is pressed onto the braid. If you have a variable temperature soldering station, you might get better results by turning up the temperature, as the combination of the wick and the connection absorbs more heat. As the solder melts, it is wicked into the braid and away from the joint. Copper is an excellent conductor of heat, and the braid can get quite hot, so watch your fingers when using braid for desoldering. After all the leads have been treated in this manner the part can be removed. (A thin film of solder may remain, but is easily broken loose through the use of needle-nose pliers.) The part of the braid that wicked up the solder is clipped off.

Do not allow the used portion of the braid get too long, as it will absorb too much heat and not do as good a job removing solder. When desoldering connections that have been made by using lead-free or "RoHS" solder, it can sometimes be difficult to achieve the high temperature needed to use solder wick, even with the iron heat turned all of the way up. A good tip in this case is to add a small amount of conventional leaded solder to the joint first, allowing it to mix. That lowers the melting point to a level that allows for much easier desoldering using solder wick, or other methods.

A desoldering vacuum pump can also be used. There are two types of desoldering vacuum tools, a simple rubber syringe bulb with a high temperature plastic tip and a desoldering pump. The desoldering pump is a simple manual vacuum pump consisting of a cylinder that contains a spring-loaded plunger attached to a metal rod inside a tip of high temperature plastic on the end of the pump. To desolder a joint, the plunger is pushed down, and locked in place. The tip is placed against the joint to be desoldered along with a soldering iron. When the solder melts, a button on the pump releases the plunger, which pulls the rod back, creating a vacuum that sucks the molten solder through the tip. The part being desoldered can then be removed. Pushing the plunger again ejects the solder from the desoldering tip.

The desoldering bulb employs a similar concept: heat the joint to be desoldered, squeeze the bulb, place the tip on the joint and release it to suck up the solder. Remove the part that was desoldered. If the first application of the desoldering pump doesn't suck up all the solder, reheat the joint and suck up the rest.

If the desoldering tool doesn't seem to be sucking up solder, the tip may be clogged with solder. The tip can be unclogged by pushing the solder through. You may have to clear the tip several times when doing a job that requires desoldering many joints. One can purchase small desoldering irons that contain a bulb on the handle that leads to a tip adjacent to the iron tip. This desoldering iron combination is somewhat easier to handle than the separate bulb and iron and does an effective job. Use a glass ashtray for a container to blow out the excess solder from this tool before using it again, as an ashtray is usually designed to handle heat.

Desoldering stations are also available. One type contains a vacuum pump in a console much like a soldering station. A vacuum line is connected to the tip of the soldering iron. There is a valve trigger on the iron that is used to open the tip to the vacuum when the solder is melted. The solder is sucked up the line into a receptacle in the station or in the hand piece. Another type of desoldering station that is commonly used in industry heats the joint with hot air so the component can be lifted off with pliers. These are particularly convenient to use and have the advantage that the hot air can be used for soldering surface mount devices.

Use surplus circuit boards to practice soldering and desoldering techniques. Old boards from all kinds of electronic items are often at very low cost or free at many flea markets. Use these surplus boards to practice different soldering and desoldering techniques without having to worry about damaging a project. Computer boards are often made with lead-free solder, and are ideal for practicing desoldering methods by adding leaded solder to the connections before desoldering.

23.3.5 Soldering Safety

Soldering requires a certain degree of practice and, of course, the right tools. What potential hazards are involved?

Since the solder used for virtually all electronic components is a lead-tin alloy, the first thing in most people's minds is lead, a well-known health hazard. There are two primary ways lead might enter our bodies when soldering: we could breathe lead fumes into our lungs or we could ingest (swallow) lead or lead-contaminated food. Inhalation of lead fumes is extremely unlikely because the temperatures ordinarily used in electronic

soldering are far below those needed to vaporize lead. Nevertheless, since lead is soft and we may tend to handle it with our fingers, contaminating our food is a real possibility. For this reason, wash your hands carefully after any soldering (or touching of solder connections).

Using a small fan can keep the fumes away from your eyes and reduce your exposure to solder smoke. A small computer chipset fan, often only an inch or two wide, can be used. By reducing the voltage that feeds the fan, the speed and noise can be reduced, allowing the fumes to be blown away, yet not creating another problem with the airflow. Look in old computers for these little fans, often attached to video cards or to the bus chips on the motherboard. The CPU or case fans can be also used, but the voltage supplying them will definitely need to be reduced to create the desired level of airflow. There are also commercially available specialized fans with built-in filters designed for this purpose.

Soldering equipment gets *hot*! Be careful. Treat a soldering iron as you would any other hot object. A soldering iron stand is helpful, preferably one that has a cage that surrounds the hot tip of the iron. Here's a helpful tip—if the soldering iron gets knocked off the bench, train yourself not to grab for it because the chances are good that you'll grab the hot end!

When heated, the flux in solder gives off a vapor in the form of a light gray smoke-like plume. This flux vapor, which often contains aldehydes, is a strong irritant and can cause potentially serious problems to persons who suffer from respiratory sensitivity conditions such as asthma. In most cases it is relatively easy to use a small fan, like the small computer fans described previously to move the flux vapor away from your eyes and face. Opening a window provides additional air exchange.

Solvents are often used to remove excess flux after the parts have cooled to room temperature. Minimize skin contact with solvents by wearing molded gloves resistant to the

solvent. If you use a solvent to remove flux, it is best to use the mildest one that does the job. Isopropyl alcohol, or rubbing alcohol, is often sufficient. You can purchase alcohol ranging from 70% to 92% concentration at local drug stores that works well in removing most types of fluxes. Some water-soluble solder fluxes can be removed with water.

Observe these precautions to protect yourself and others:

- Properly ventilate the work area. If you can smell fumes, you are breathing them.
- Wash your hands after soldering, especially before handling food.
- Minimize direct contact with flux and flux solvents. Wear disposable surgical gloves when handling solvents.

For more information about soldering hazards and the ways to make soldering safer, see "Making Soldering Safer," by Brian P. Bergeron, MD, NU1N (Mar 1991 *QST*, pp 28-30) and "More on Safer Soldering," by Gary E. Meyers, K9CZB (Aug 1991 *QST*, p 42).

23.4 Surface Mount Technology (SMT)

Today, nearly all consumer electronic devices are made with surface mount technology. Hams have lagged behind in adopting this technology largely due to the misconception that it is difficult, requires extensive practice and requires special equipment. In fact, surface mount devices can be soldered easily with commonly available equipment. There is no more practice required to become proficient enough to produce a circuit with surface-mount (SM) devices than there is with soldering through-hole (leaded) components.

There are several advantages to working with SMT:

- Projects are much more compact than if through-hole components are used
- SM parts are available that are not available in through-hole packages
- Fewer and fewer through-hole parts are being produced
- Equivalent SM components are often cheaper than through-hole parts, and
- SM parts have less self-inductance, less self-capacitance and better thermal properties.

There are several techniques that can be used effectively to work with SM components: conventional soldering iron, hot air reflow and hot plate/hot air reflow. This section describes the soldering iron technique. On-line descriptions of reflow techniques are available for the advanced builder that wants to try them. As is the case for through-hole soldering, kits are available to teach the beginner how to solder SMT components.

The following material on working with surface-mount technology contains excerpts from a series of *QST* articles, "Surface Mount Technology — You Can Work with It! Part 1" by Sam Ulbing, N4UAU, published in the April 1999 issue. (The entire series of four articles is available on the CD-ROM included with this book. Additional information on SMT is available at www.arrl.org/surface-mount-technology.) Additional information and illustrations were contributed by George Heron, N2APB.

23.4.1 Equipment Needed

You do not need lots of expensive equipment to work with SM devices.

- A fundamental piece of equipment for SM work is an illuminated magnifying glass. You can use an inexpensive one with a 5 inch diameter lens, and it's convenient to use the magnifier for all soldering work, not just for SM use. Such magnifiers are widely available from about \$25. Most offer a 3× magnification and have a built-in circular light.

- A low-power, temperature-controlled soldering iron is necessary. Use a soldering iron with a grounded tip as most SM parts are CMOS devices and are subject to possible ESD (static) failure.

- Use of thin (0.020 inch diameter) rosin-core solder is preferred because the parts are so small that regular 0.031 inch diameter solder will flood a solder pad and cause bridging. Solder paste or cream can also be used.

- A flux pen comes in handy for applying

just a little flux at a needed spot.

- Good desoldering braid is necessary to remove excess solder if you get too much on a pad. 0.100 inch wide braid works well.

- ESD protective devices such as wrist straps may be necessary if you live in a dry area and static is a problem.

- Tweezers help pick up parts and position them. Nonmagnetic, stainless-steel drafting dividers also work well. The nonmagnetic property of stainless steel means the chip doesn't get attracted to the dividers.

- Some hams prefer to hold components in place with a temporary adhesive such as DAP Blue-Stik while soldering rather than holding the part with tweezers.

23.4.2 Surface-Mount Parts

Fig 23.4 shows some common SM parts. (The **Component Data and References** chapter has more information on component packages.) Resistors and ceramic capacitors come in many different sizes, and it is important to know the part size for two reasons: Working with SM devices by hand is easier if you use the larger parts; and it is important that the PC-board pad size is larger than the part.

Discrete component packaging has shrunk to 0.12 × 0.06 inch, as shown in the "1206" capacitor in **Fig 23.5** compared to a penny. Even smaller packages are common today, requiring much less PC board area for the same equivalent circuits. Integrated circuit packaging has also been miniaturized to cre-

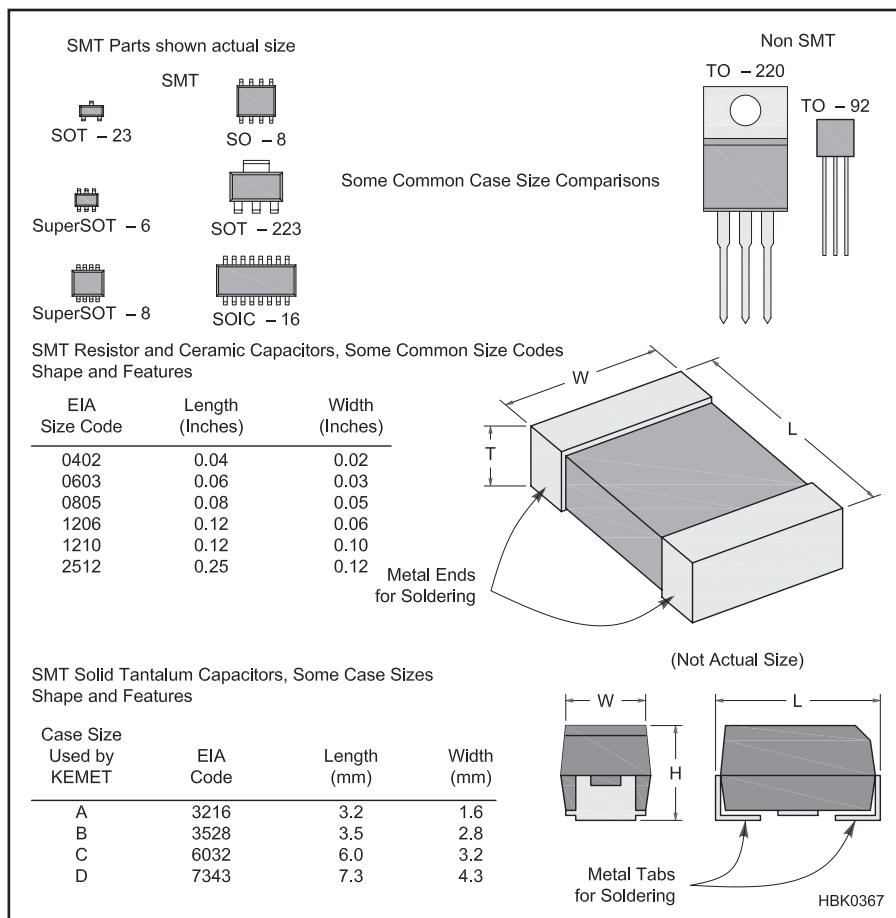


Fig 23.4 — Size comparisons of some surface-mount devices and their dimensions. See the Component Data and References chapter for more information about component packages and labeling.

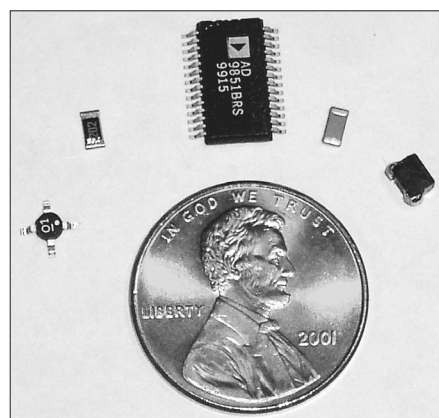


Fig 23.5 — SMT components are small. Clockwise from left: MMIC RF amp, 1206 resistor, SOIC integrated circuit, 1206 capacitor and ferrite inductor.

ate 10 × 5 mm SOIC packages with lead separations of 0.025 inch.

Tantalum capacitors are one of the larger SM parts. Their case code, which is usually a letter, often varies from manufacturer to manufacturer because of different thicknesses. The EIA code for ceramic capacitors



Fig 23.6 — A magnifying visor is great for close-up work on a circuit board. These headsets are often available for less than \$10 at hamfests and some even come with superbright LEDs mounted on the side to illuminate the components being soldered.

and resistors is a measurement of the length and width in inches, but for tantalum parts, those measurements are in millimeters times 10! Keep in mind that tantalum capacitors are polarized; the case usually has a mark or stripe to indicate the positive end. Nearly any part that is used in through-hole technology

is available in an SM package.

If you are a beginner, it is probably best to start with the larger sizes — 1206 for resistors and capacitors, SOT-23 for transistors, and SO-8 for ICs. When you get proficient with these parts you can move to smaller ones.

PREPARING FOR SMT WORK

The key to success with any construction project is selecting and using the proper tools. A magnifying lamp is essential for well-lighted, close-up work on the components. **Fig 23.6** shows a convenient magnifying visor. Tweezers or fine-tipped pliers allow you to grab the small chip components with dexterity.

A clean work surface is of paramount importance because SMT components have a tendency to slip from pliers or tweezers and fly off even when held with the utmost care. You'll have the best chance of recovering your wayward part if your table is clear. When the inevitable happens, you'll have lots of trouble finding it if the part falls onto a rug. It's best to have your work area in a room without carpeting, for this reason as well as to protect static-sensitive parts.

23.4.3 SMT Soldering Basics

If the project contains both SM parts and conventional through-hole parts and you intend to use a heat-gun or oven for reflow soldering, always mount the SM parts first, as through-hole components are not always designed to handle the higher reflow heat levels. Use junk PC boards to practice your soldering and desoldering techniques for SM parts until you are comfortable beginning your own project.

USING A SOLDERING IRON

Let's look at how to solder a surface-mount IC with a soldering iron. Use a little solder to pre-tin the PC board pads if the board is not already pre-tinned. The trick is to add just enough solder so that when you reheat it, it flows to the IC, but not so much that you wind up with a solder bridge. Putting a (very) little flux on the board and the IC legs makes for better solder flow, providing a smooth layer. You can tell if you have the proper soldering-iron tip temperature if the solder melts within 1.5 to 3.5 seconds.

Place the part on the board and then use dividers (or fingers) to push and prod the chip into position. Because the IC is so small and light, it tends to stick to the soldering iron and pull away from the PC board. To prevent this, use the dividers to hold the chip down while tack-soldering two IC legs at diagonally opposite corners. After each tack, check that the part is still aligned. With a dry and clean soldering iron, heat the PC board near the leg. If you do it right, when the solder melts,

it will flow to the IC.

The legs of the IC must lie flat on the board. The legs bend easily, so don't press down too hard. Check each connection with a continuity checker placing one tip on the board the other on the IC leg. Check all adjacent pins to ensure there's no bridging. It is easier to correct errors early on, so perform this check often.

If you find that you did not have enough solder on the board for it to flow to the part, add a little solder. It's best to put a drop on the trace near the part, then heat the trace and slide the iron and melted solder toward the part. This reduces the chance of creating a bridge. Soldering resistors and capacitors is similar to soldering an IC's leads, except the resistors and capacitors don't have exposed leads. The reflow method works well for these parts, too.

Attaching wires that connect to points off the board can be a bit of a challenge because even #24 AWG stranded wire is large in comparison to the SM parts. First, make sure all the wire strands are close together, then pre-tin the wire. Pre-tin the pad, carefully place the wire on the pad, then heat it with the soldering iron until the solder melts.

USING REFLOW TECHNIQUES

While SMT projects can be built with conventional solder and a fine-point soldering iron, if you move on to reflow techniques you will need to use solder paste. Solder paste is a grayish looking paste made of a blend of flux and solder. A small dot of solder paste is put on the board at each location a component will need to be soldered. The components are then carefully placed on the board, with the paste loosely holding the parts in position. The whole board is then heated in an oven, or the area of the board being assembled is heated with a heat gun. With sufficient heat, the solder paste melts and flows onto the pad and component contacts, then the board is cooled leaving all of the components soldered in place.

A toaster oven can also be modified to perform reflow soldering as described in the article "Reflow Soldering for the Radio Amateur" by Jim Koehler, VE5FP, in the January 2011 issue of *QST* (this article is included on this book's CD-ROM). There are many on-line tutorials for adapting and using a toaster oven such as <http://hackmod.com/hack/diy-reflow-surface-mount-soldering-smd-tutorial> and www.youtube.com/watch?v=vduU4WWbpbM. SparkFun also shows how to add a temperature control to a toaster oven at www.sparkfun.com/tutorials/60. If you plan on doing a lot of SMT assembly, learning reflow techniques is well worth the effort.

For occasional SMT use, a heat gun is a better choice. Many hobby/crafts stores sell

a special heat tool that is used for melting embossing inks used in scrapbooking. Look for an embossing heat tool in the scrapbooking department of these stores. Do not get the heat gun too close to the board, as the airflow may move your components out of place. Hold the tool steady a couple of inches above the board until you see the solder paste turn silver and you see the component appear to be soldered in place, then gradually remove the heat gun. Never use a heat gun designed for paint stripping as the airflow is way too strong for this purpose and will blow the SM parts off the board.

Only a small amount of solder paste is required. Kester Easy Profile 256 is a good solder paste to start with. It is available at reasonable cost in a small syringe with a fine needle-point applicator. As only a small amount is needed for each solder joint, this small amount will last through several medium sized projects. Solder paste must be kept cold or it deteriorates. Kept in a household refrigerator or freezer it has a shelf life of at least a year.

23.4.4 Removing SMT Components

The surface-mount ICs used in commercial equipment are not easy for experimenters to replace. They have tiny pins designed for precision PC boards. Sooner or later, you may need to replace one, though. If you do, don't try to get the old IC out in one piece! This will damage the IC beyond use anyway, and will probably damage the PC board in the process.

Although it requires a delicate touch and small tools, it's possible to change a surface mount IC at home. To remove the old one, use small, sharp wire cutters to cut the IC pins flush with the IC. This usually leaves just enough of the old pin to grab with tweezers. Heat the soldered connection with a small iron and use the pliers to gently pull the pin from the PC board. Use desoldering braid to remove excess solder from the pads and remove and flux with rubbing alcohol. Solder in the new component using the techniques discussed above.

You can also use the embossing heat gun previously described to remove SM parts, especially ICs. Keep in mind that not only the desired component, but some adjacent parts as well may be loosened by this process, so be sure to not move the board during reheating to allow the other components to stay in place. Use a long-handled tweezers to remove a component once you see the solder become silvery again. Be careful to not disturb any adjacent components. Allow the board to thoroughly cool before moving it to prevent inadvertently allowing other components to shift before the solder solidifies again.

To remove individual components without a heat gun, first remove excess solder from the pads by using desoldering braid. Then the component will generally come loose from the pads if gently lifted with a hobby knife or dental tool. If the component remains attached to the pad, touch the pad with the soldering iron and lift the component off the pad. It may take one or two attempts to free the component from all pads. In extreme cases, it may be necessary to add solder to the pad to completely loosen the component.

23.4.5 SMT Construction Examples

The first project example is the DDS Daughtercard — a small module that generates precision RF signals for a variety of projects. This kit has become immensely popular in homebrew circles and is supplied with the chip components contained in color-coded packaging that makes an easy job of identifying the little parts, a nice touch by a kit supplier.

Fig 23.7A shows the DDS PC board, a typical layout for SMT components. All traces are on one side, since the component leads are not "through-hole." The little square pads are the places where the 1206 package-style chips will eventually be soldered. This project demonstrates the reflow technique using a soldering iron. **Fig 23.7B** illustrates how to use this technique.

(a) Pre-solder ("tin") one of the pads on the board where the component will ultimately go by placing a small blob of solder there.

(b) Carefully hold the component in place with small needle-nose pliers or sharp tweezers on the tinned pad.

(c) Reheat the tinned pad and component to reflow the solder onto the component lead, thus temporarily holding the component in place.

(d) Solder the other end of the component to its pad.

(e) Finally, check all connections to make sure there are no bridges or shorts.

Fig 23.7C shows the completed DDS board.

The second project example is the K8IQY Audio Amp — a discrete component audio amplifier that is homebrew-constructed "Manhattan-style" as described later in the chapter in which small pads are glued or soldered to the copper-clad base board wherever you need to attach component leads or wires. See **Fig 23.7D**.

Instead of using little squares or dots of PC board material for pads, you might decide to create isolated connection points by cutting an "island" in the copper using an end mill or pad cutter. No matter how the pads are created, SMT components may be easily soldered from pad-to-pad, or from pad-to-

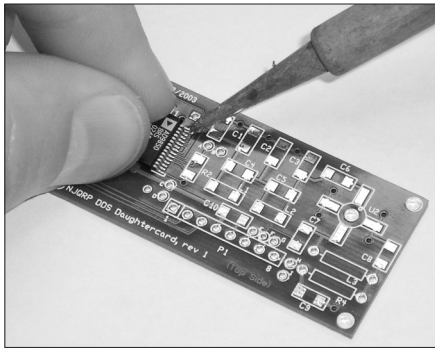


Fig 23.7A — This DDS Daughtercard has all interconnections on the top side. Connections to the ground plane on the backside of the board are made by the use of “vias,” wires through the PC board. Pin 28 of the SMT IC is shown being tack-soldered to hold it to the board, keeping all other pins carefully aligned on their pads. Then the other pins are carefully soldered, starting with pin 14 (opposite pin 28). Finally, pin 28 is reheated to ensure a good connection there. If you bridge solder across adjacent pads or pins, use solder wick or a vacuum solder sucker to draw off the excess solder.

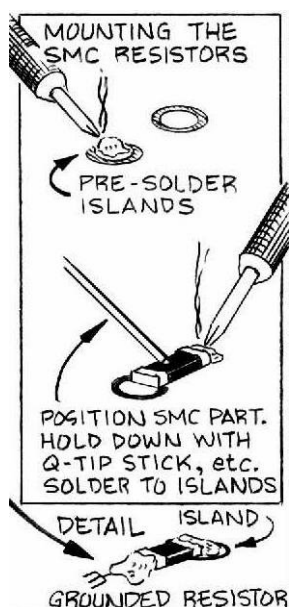


Fig 23.7B — Attaching an SMT part. It is a lot easier attaching capacitors, resistors and other discrete components compared to multi-pin ICs. Carefully hold the component in place and properly aligned using needle-nose pliers or tweezers and then solder one end of the component. Then reheat the joint while gently pushing down on the component with the pliers or a Q-tip stick to ensure it is lying flat on the board. Finally, solder the other side of the component.

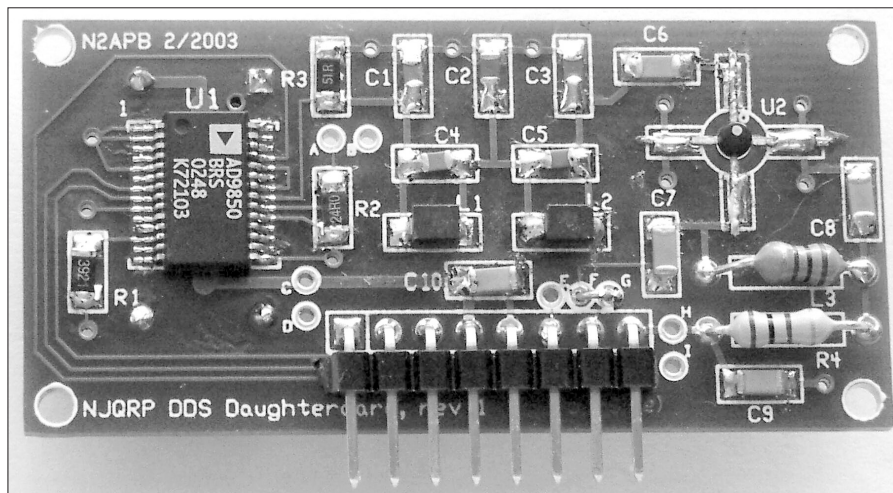


Fig 23.7C — The fully-populated DDS Daughtercard PC board contains a mix of SMT and through-hole parts, showing how both packaging technologies can be used together.

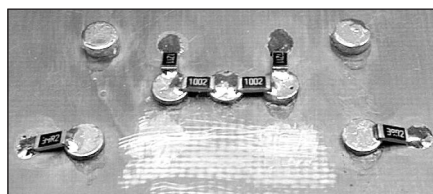


Fig 23.7D — SMT resistors soldered to base board of the Audio Amp in the beginning stages of assembly.

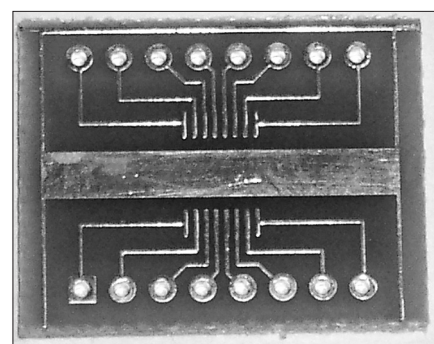


Fig 23.7F — Surface mount ICs can be mounted to general-purpose carrier boards, then attached as a submodule with wires to the base board of the homebrew project.

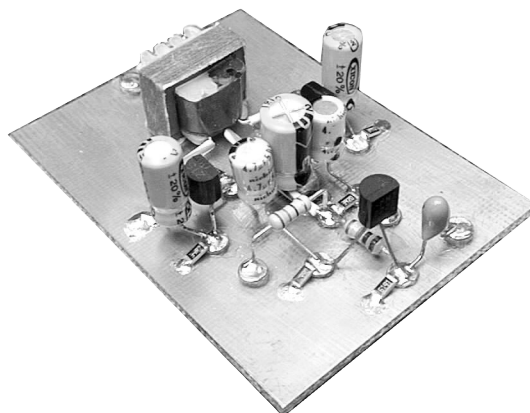


Fig 23.7E — The completed homebrew Audio Amp assembly shows simple, effective use of SMT components used together with conventional leaded components when constructed “Manhattan-style.”

ground plane to build up the circuit. **Fig 23.7E** shows the completed board, combining SMT and leaded components.

Homebrewing with SOIC-packaged integrated circuits is a little trickier and typically requires the use of an “SOIC carrier board” such as the one shown in **Fig 23.7F**, onto which you solder your surface-mount integrated circuit. You can then wire the carrier board onto your base board or whatever you’re using to hold your other circuit components.

Full details on the DDS Daughtercard, the K8IQY Islander Audio Amp, and the Islander Pad Cutter may be found online at www.njqrp.org.

23.5 Constructing Electronic Circuits

Most of the construction projects undertaken by the average amateur involve electronic circuitry. The circuit is the “heart” of most amateur equipment. It might seem obvious, but in order for you to build it, the circuit must work! Don’t always assume that a “cookbook” circuit that appears in an applications note or electronics magazine is flawless. These are sometimes design examples that have not always been thoroughly debugged. Many home-construction projects are one-time deals; the author has put one together and it worked. In some cases, component tolerances or minor layout changes might make it difficult to get a second unit working. Using a solderless breadboard can make it easier to test this type of circuit design. For RF circuits above a few MHz, a solderless breadboard is not always practical due to long lead lengths that result.

Take steps to protect the electronic and mechanical components you use in circuit construction. Some components can be damaged by rough handling. Dropping a $\frac{1}{4}$ W resistor causes no harm, but dropping a vacuum tube or other delicate subassemblies usually causes damage.

Some components are easily damaged by heat. Some of the chemicals used to clean electronic components (such as flux removers, degreasers or control-lubrication sprays) can damage plastic. Check them for suitability before you use them.

23.5.1 Electrostatic Discharge (ESD)

Some components, especially high-impedance components such as FETs and CMOS gates, can be damaged by electrostatic discharge (ESD). Protect these parts from static charges. Most people are familiar with the static charge that builds up when one walks across a carpet then touches a metal object; the resultant spark can be quite lively. Walking across a carpet on a dry day can generate 35 kV! A worker sitting at a bench can generate voltages up to 6 kV, depending on conditions, such as when relative humidity is less than 20%.

You don’t need this much voltage to damage a sensitive electronic component; damage can occur with as little as 30 V. The damage is not always catastrophic. A MOSFET can become noisy, or lose gain; an IC can suffer damage that causes early failure. To prevent this kind of damage, you need to take some precautions.

The energy from a spark can travel inside a piece of equipment to affect internal components. Protection of sensitive electronic components involves the prevention of static

build-up together with the removal of any existing charges by dissipating any energy that does build up.

MINIMIZING STATIC BUILD-UP

Several techniques can be used to minimize static build-up. Start by removing any carpet in your work areas. You can replace it with special antistatic carpet, but this is expensive. It’s less expensive to treat the carpet with antistatic spray, which is available from electronics wholesalers. Adding humidity to the air can help reduce the presence of static charges as well.

Even the choice of clothing you wear can affect the amount of ESD. Polyester has a much greater ESD potential than cotton.

Many builders who have their workbench on a concrete floor use a rubber mat to minimize the risk of electric shocks from the ac line. Unfortunately, the rubber mat increases the risk of ESD. An antistatic rubber mat can serve both purposes.

Many components are shipped in antistatic packaging. Leave components in their conductive packaging. Other components, notably MOSFETs, are shipped with a small metal ring that temporarily shorts all of the leads together. Leave this ring in place until the device is fully installed in the circuit.

Use antistatic bags to transport susceptible components or equipment. Keep your workbench free of objects such as paper, plastic

and other static-generating items. Use conductive containers with a dissipative surface coating for equipment storage. Storing partially assembled projects in antistatic bags is also a good idea.

These precautions help reduce the build-up of electrostatic charges. Other techniques offer a slow discharge path for the charges or keep the components and the operator handling them at the same ground potential.

DISSIPATING STATIC

One of the best techniques is to connect the operator and the devices being handled to earth ground, or to a common reference point. It is not a good idea to directly ground an operator working on electronic equipment, though; the risk of shock is too great. If the operator is grounded through a high-value resistor such as 100 k Ω to 1 M Ω , ESD protection is still offered but there is no risk of shock.

The operator is usually grounded through a conductive wrist strap. This wrist band is equipped with a snap-on ground lead. A 1 M Ω resistor is built into the snap of the strap to protect the user should a live circuit be contacted. Build a similar resistor into any homemade ground strap.

The devices and equipment being handled are also grounded, by working on a charge-dissipating mat that is connected to ground. The mat should be an insulator that has been impregnated with a resistance mate-

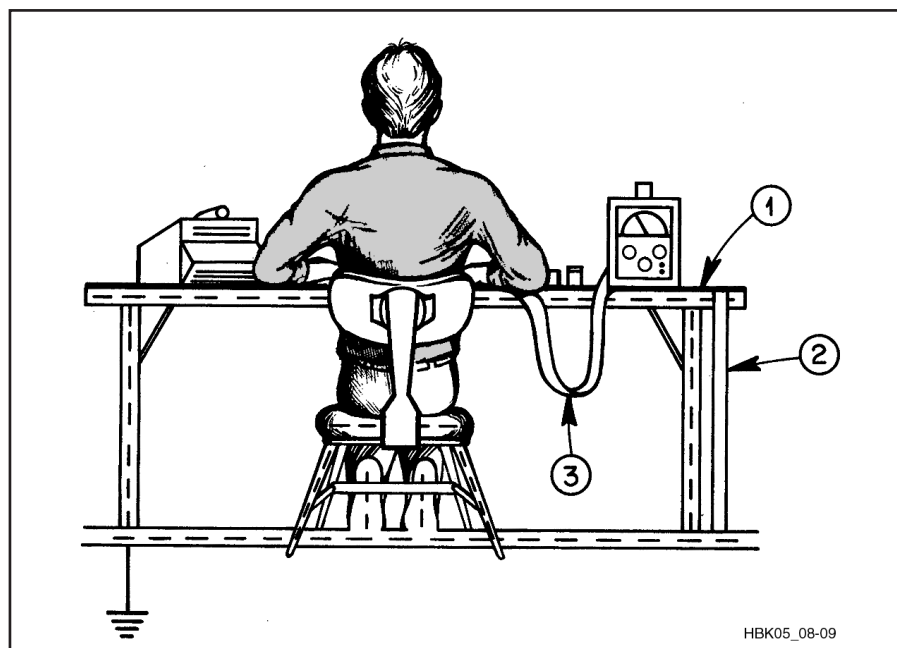


Fig 23.8 — A work station that has been set up to minimize ESD features (1) a grounded dissipative work mat and (2) a wrist strap that (3) grounds the worker through high resistance.

rial. Suitable mats and wrist straps are available from most electronics supply houses. **Fig 23.8** shows a typical ESD-safe work station.

The work area should also be grounded, directly or through a conductive mat. Use a soldering iron with a grounded tip to solder sensitive components. Most irons that have three-wire power cords are properly grounded. When soldering static-sensitive devices, use two or three jumpers: one to ground you, one to ground the work, and one to ground the iron. If the iron does not have a

ground wire in the power cord, clip a jumper from the metal part of the iron near the handle to the metal box that houses the temperature control. Another jumper connects the box to the work. Finally, a jumper goes from the box to an elastic wrist band for static grounding.

23.5.2 Sorting Parts

When building a project, especially one packaged as a kit, finding the appropriate container to sort your components can be a problem. There are a number of things that

make this task a lot easier and at a low cost.

Using a plastic egg carton or poking component leads into Styrofoam works quite well for sorting parts, but both methods can lead to ESD damage of sensitive components. Use this method for components such as resistors, capacitors and inductors that are relatively immune to ESD.

Metal cupcake trays are ideal, as the tray itself can be grounded through a 1 M Ω resistor to prevent static buildup. Cupcake trays typically come in three sizes: 6, 12 and 16 cups. The best sorting technique is to place the

How to Buy Parts for Electronics Projects

The number one question received by the ARRL Technical Information Service starts out “Where can I buy...” It seems that one of the most perplexing problems faced by the would-be constructor is where to get parts. Sometimes you are lucky — the project author has made a kit or a PC board or key parts available. But not every project has a ready-made kit. If you would like to expand your construction horizons, you can learn to be your own “purchasing manager.” That means searching out parts sources and dealing with them yourself.

In reality, it is not all that difficult to find most parts. If you are lucky, you may have a local source of electronics parts. Look in the Yellow Pages under “Electronic Equipment Suppliers” to find the local outlets. RadioShack is one local source found nearly everywhere. They carry an assortment of the more common electronic parts.

Unfortunately, though, in many areas of the country it's just not possible to find a local electronic parts supplier that can provide everything for your next project. This is not surprising. Years ago an electronics supplier had to stock a relatively small number of electronic components — resistors, capacitors, tube sockets, a few relays and variable resistors. Technology has increased the number of components by a few orders of magnitude.

Nowadays, the number of integrated circuits alone is enough to fill a multi-volume book. No single electronics supplier could possibly stock them all. It has become a mail-order world; the electronics world is no exception. If you can't find what you need locally to fill your electronic needs, the good news is that an astonishing variety of components is literally a mouse click or phone call away.

Almost all of these suppliers have detailed catalogs on their websites, and some offer printed catalogs. Bookmark the websites and collect their catalogs, and you'll have a ready source of parts for your next project. It's good to have a variety of sources, as you'll probably need to order from more than one company. (It's almost a corollary to Murphy's Law: No matter how wide a selection you find at one supplier, there's always at least one part you must buy somewhere else!)

When planning for a project you want to build, you need to convert the parts list and/or schematic into a parts-order list that shows the catalog number and quantity required of each component. This may require a similar list for each vendor when one supplier does not have all the parts.

Check the type, tolerance, power rating and other key characteristics of the parts. Group the parts by those parameters before grouping them by value. If all of the circuit's components are already grouped by value on the parts list, you can just count the number of each value. Each time you add parts to the order list, check them off the published parts list. Sometimes the parts list does not include common components like resistors and capacitors. If this is the case, make a copy of the schematic and

check off the parts as you build your shopping list.

It's generally a good idea to locate sources for all needed parts before ordering anything. Sometimes a key component can be hard to find in small quantities, prohibitively expensive, or obsolete. Be prepared to substitute similar parts if the exact ones needed are not available.

Although you'll probably be able to order exactly the right number of each part for a project, buy a few extras of some parts for your junk box. It's always good to have a few extra parts on hand; you may break a component lead during assembly, or damage a solid-state component with too much heat or by wiring it in backwards. If you don't have extras, you'll need to order another part. Even if you don't need the extras for this project, they may come in handy, and you'll be encouraged to build another project! Pick up an extra toroid or two as well.

Now's the time to decide whether you're going to build your project with ground-plane construction or PC board. If you need a PC board, FAR Circuits (www.farcircuits.net) and others have them for many ARRL book and QST projects. If one is available, that information is usually included in the article. If you're going to use ground-plane construction, buy a good-sized piece of single-sided copper-clad board — glass-epoxy board if you can. Phenolic board is inferior because it is brittle and deteriorates rapidly with soldering heat.

Don't forget an enclosure for your project. This is often overlooked in parts lists for most projects, because different builders like different enclosures. Make sure there's room in the box for all of the components used in your project. Some people like to cram projects in the smallest possible box, but miniaturization can be extremely frustrating if you're not good at it.

There are almost always a few items you can't get from one company and most have minimum orders. You may need to distribute your order between two or more companies to meet minimum-order requirements.

If you order enough parts, you'll soon find out which companies you like to deal with and which have slow service. It is frustrating to receive most of an order, then wait months for the parts that are on backorder. Fortunately, most of the larger suppliers indicate stock status on their websites. And most companies that cater to hams can tell you over the phone if a part is out of stock.

If you're ordering by mail and don't want the company to backorder your parts, write clearly on the order form, “Do not backorder parts.” They will then ship the parts they have and leave you to order the rest from somewhere else.

If you are familiar with the websites, catalogs and policies of electronic-component suppliers, you will find that getting parts is not difficult. Concentrate on the fun part — building the circuit and getting it working. — *Bruce Hale, KB1MW*

most common or first-used components in the cups closest to the builder (usually resistors), with the least used parts (usually mounting hardware) in the farther cups.

Another great idea for parts sorting is to use a fishing tackle box with removable trays. Inexpensive tackle boxes are available at outdoor supply houses and department stores, and you can often find them on sale. The tackle box has a distinct advantage of allowing you to sort your parts into different compartments within each movable tray, and some trays have pieces that allow you to re-size the compartments to better fit the parts for your project. Many tackle boxes have a larger open space in the top which allows you to store your partially finished boards, with the remaining components in the closeable trays below it. This arrangement is ideal to protect your project from damage and can be securely stored between work sessions.

23.5.3 Construction Order

When building a kit or DIY project, the question often arises as to what order the parts need to be mounted. In a kit, the manual often is very explicit, requiring the builder to construct the project stage by stage. Other kit manuals offer only a minimum of directions, leaving it up to the builder. Have the manual handy, either printed or on a laptop or tablet nearby for reference.

In stage by stage construction, each stage in the project is completed in order to allow the builder to test and troubleshoot that area of the project without having a more complex problem to solve with all components mounted. This method also allows the builder to learn the principles involved in the project and how each part of the circuit works from the power supply to the output. This is a great aid to future modification and repair.

When building a kit in stages, it is often better to sort the parts by stages as well, placing the parts from each stage in their own space. That way, when each stage is completed, there should be no extra parts left over in that stage's container. Number the stages, if they are not already numbered in the manual, and place a small piece of paper with that number in each compartment, indicating the stage that those parts belong to.

When given a minimum of assembly instructions, the best approach is to mount the resistors first, then the capacitors, and then the semiconductors, followed by the more unique components. This way, the majority of parts are mounted early in the process, so finding the remaining part locations is a lot easier. This technique also allows the builder to double check the usage of parts. Try to mount large parts after the smaller surrounding parts so as not to possibly block your ability to properly mount all of them.

Inventory the parts before commencing construction. In kits or DIY projects, if a change is introduced after a number of kits have been assembled, there is a chance of errors so that the parts list or board layouts do not reflect changes in the design of the circuit. Sometimes, a number of extra parts are supplied with a kit to facilitate different options, such as the choice of bands covered. Sometimes parts are eliminated or substituted with a change of other components in the circuit. Be sure to ask the kit supplier if you are not sure as to why you have an empty space or surplus parts. Always resolve any questions about component placement before powering up a completed project.

23.5.4 Component Mounting

When working with a large number of components, there are a few techniques that can be helpful should troubleshooting be required. Although resistors are not polarized, it is a good idea to mount them with the color codes reading the same direction to make it easier to spot a part that is not in its correct position. Polarity-sensitive parts, such as diodes, electrolytic capacitors and ICs, must be placed in their specified direction. In general, mount components so their values are readable without having to remove the component from the board or bending it, causing possible damage.

Axial-lead components such as resistors are mounted in one of two methods, upright and flat. To save space on a PC board, resistors are often mounted upright with one lead bent double in a manner resembling a hairpin. The best practice is to make this bend so that the color stripes denoting the resistor value begin at the top and the precision stripe (often silver or gold) is at the bottom, making it easier to read the values once mounted. Components with alphanumeric markings, such as diodes, should be mounted with the markings visible.

Non-polarized capacitors are best placed with markings facing in the same direction, unless the markings would be blocked by another component.

For polarized parts, always double-check its positioning before soldering. A commercially-prepared PC board often has stripes on the diode labels, indicating which end to place the cathode stripe on the diode. A "+" sign on the board inside or next to the circle for a capacitor denotes the positive lead which will often be longer. LEDs will have a flat spot on or a notch on a lead to identify the cathode. See the **Component Data and References** chapter and manufacturers' data sheets for more information on component body styles.

When mounting ICs, using a pin straightener helps align the leads for insertion. If one is not available, use a flat surface to align them at once. Be sure a pin does not get bent

inward and that all pins go into the socket or PC board holes.

23.5.5 Electronics Construction Techniques

Several different point-to-point wiring techniques or printed-circuit boards (PC boards) can be used to construct electronic circuits. Most circuit projects use a combination of techniques. The selection of techniques depends on many different factors and builder preferences.

For one-time construction, PC boards are really not necessary. It takes time to lay out, drill and etch a PC board. Alterations are difficult to make if you change your ideas or make a mistake.

The simple audio amplifier shown in **Fig 23.9** will be built using various point-to-point or PC-board techniques. This shows how the different construction methods are applied to a typical circuit. (Surface-mount techniques are discussed in the previous section.)

POINT-TO-POINT TECHNIQUES

Point-to-point techniques include all circuit construction techniques that rely on tie points and wiring, or component leads, to build a circuit. This is the technique used in most home-brew construction projects. It is sometimes used in commercial construction, such as old vacuum-tube receivers and modern tube amplifiers.

Point-to-point wiring is also used to connect the "off-board" components used in a printed-circuit project. It can be used to interconnect the various modules and printed-circuit boards used in more complex electronic systems. Most pieces of electronic equipment have at least some point-to-point wiring.

GROUND-PLANE CONSTRUCTION

A point-to-point construction technique that uses the leads of the components as tie

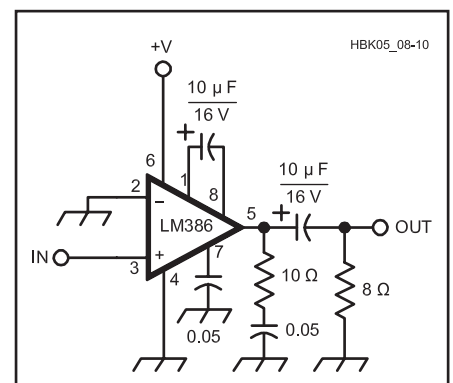


Fig 23.9 — Schematic diagram of the audio amplifier used as a design example of various construction techniques.

points for electrical connections is known as “ground-plane,” “dead-bug” or “ugly” construction. “Dead-bug construction” gets its name from the appearance of an IC with its leads sticking up in the air. In most cases, this technique uses copper-clad circuit-board material as a foundation and ground plane on which to build a circuit using point-to-point wiring, so in this chapter it is called “ground-plane construction.” An example is shown in Fig 23.10.

Ground-plane construction is quick and simple: You build the circuit on an unetched piece of copper-clad circuit board. Wherever a component connects to ground, you solder it to the copper board. Ungrounded connections between components are made point-to-point. Once you learn how to build with a ground-plane board, you can grab a piece of circuit board and start building any time you see an interesting circuit.

A PC board has strict size limits; the components must fit in the space allotted. Ground-plane construction is more flexible; it allows you to use the parts on hand. The circuit can be changed easily — a big help when you are experimenting. The greatest virtue of ground-plane construction is that it is fast.

Ground-plane construction is something like model building, connecting parts using solder almost — but not exactly — like glue. In ground-plane construction you build the circuit directly from the schematic, so it can help you get familiar with a circuit and how it works. You can build subsections of a large circuit on small ground-plane modules and string them together into a larger design.

Circuit connections are made directly, minimizing component lead length. Short lead lengths and a low-impedance ground conductor help prevent circuit instability. There is usually less inter-component capacitive coupling than would be found between PC-board traces, so it is often better than PC-board construction for RF, high-gain or sensitive circuits.

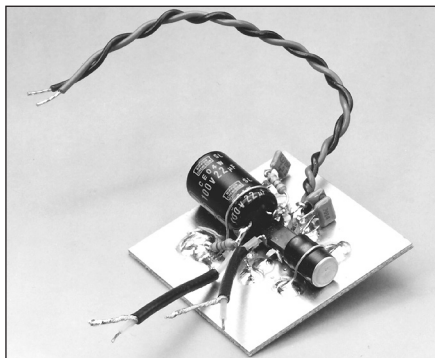


Fig 23.10 — The example audio amplifier of Fig 23.9 built using ground-plane construction.

Use circuit components to support other circuit components. Start by mounting one component onto the ground plane, building from there. There is really only one two-handed technique to mount a component to the ground plane. Bend one of the component leads at a 90° angle, and then trim off the excess. Solder a blob of solder to the board surface, perhaps about 0.1 inch in diameter, leaving a small dome of solder. Using one hand, hold the component in place on top of the solder spot and reheat the component and the solder. It should flow nicely, soldering the component securely. Remove the iron tip and hold the component perfectly still until the solder cools. You can then make connections to the first part.

Connections should be mechanically secure before soldering. Bend a small hook in the lead of a component, then “crimp” it to the next component(s). Do not rely only on the solder connections to provide mechanical strength; sooner or later one of these connections will fail, resulting in a dead circuit.

In most cases, each circuit has enough

grounded components to support all of the components in the circuit. This is not always possible, however. In some circuits, high-value resistors can be used as standoff insulators. One resistor lead is soldered to the copper ground plane; the other lead is used as a circuit connection point. You can use ¼ or ½ W resistors in values from 1 to 10 MΩ. Such high-value resistors permit almost no current to flow, and in low-impedance circuits they act more like insulators than resistors. As a rule of thumb, resistors used as standoff insulators should have a value that is at least 10 times the circuit impedance at that point in the circuit.

Fig 23.11A shows how to use the standoff technique to wire the circuit shown at Fig 23.11C. Fig 23.11B shows how the resistor leads are bent before the standoff component is soldered to the ground plane. Components E1 through E5 are resistors that are used as standoff insulators. They do not appear in the schematic diagram. The base circuitry at Q1 of Fig 23.11A has been stretched out to reduce clutter in the drawing.

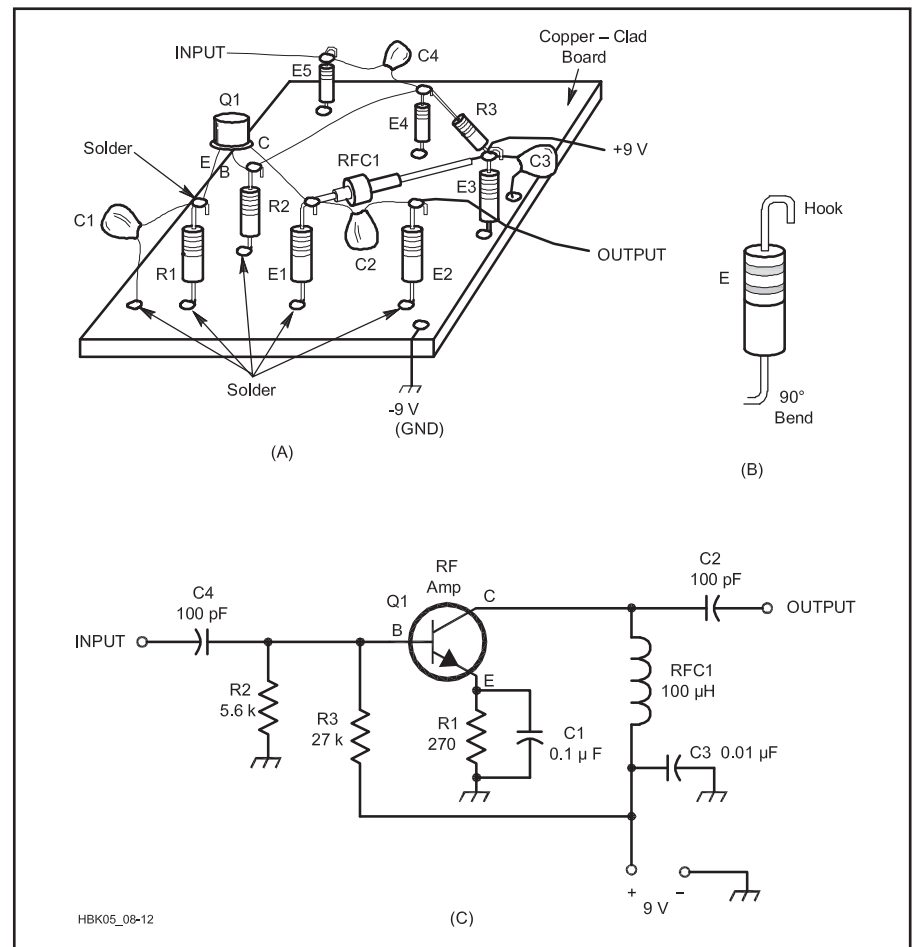


Fig 23.11 — Pictorial view of a circuit board that uses ground-plane construction is shown at A. A close-up view of one of the standoff resistors is shown at B. Note how the leads are bent. The schematic diagram at C shows the circuit displayed at A.

In a practical circuit, all of the signal leads should be kept as short as possible. E4 would, therefore, be placed much closer to Q1 than the drawing indicates.

No standoff posts are required near R1 and R2 of Fig 23.11. These two resistors serve two purposes: They are not only the normal circuit resistances, but function as standoff posts as well. Follow this practice wherever a capacitor or resistor can be employed in the dual role.

"MANHATTAN" CONSTRUCTION

Another solution to building up a circuit is called "Manhattan" construction, shown previously in the Surface-Mount Components section as Fig 23.7E. This method got its name from the appearance of the finished product, resembling the tall buildings in a city. Manhattan construction uses plain, unetched copper clad PC board material to make both the main board and the component connection points. The PC board material used may be single or double-sided.

After cutting the desired size and shape of the board required for the project, use the scraps left over to make the insulated contact pads. These pads can be made a number of ways, the most common being cutting the material into tiny squares about $\frac{1}{4}$ or $\frac{3}{8}$ inch across. Another method to create the pads is to use a heavy-duty hole punch. This kind of punch often has changeable dies to create various sizes of round holes in materials such as sheet metal, and is available at many tool dealers. Once cut, the pads can be glued to the board in a pattern that accommodates the lead lengths of the parts to be connected.

Pads can be glued to the base board or soldered if the pads are double-sided PC board material. Use a tiny drop of instant glue, such as a cyanoacrylate "super glue" to mount the pads to the board. When soldering to the pads, use the minimum amount of heat required to avoid loosening the pads.

Component leads are soldered to the pads, and additional leads can be added to a pad by simply reheating the connection already there. The main board is used as the ground plane with all ground leads soldered to the board. This method of construction works well with RF circuits up to UHF.

WIRED TRACES — THE LAZY PC BOARD

If you already have a PC-board design, but don't want to copy the entire circuit — or you don't want to make a double-sided PC board — then the easiest construction technique is to use a bare board or perfboard and hardwire the traces.

Drill the necessary holes in a piece of single-sided board, remove the copper ground plane from around the holes, and then wire up the back using component leads and bits

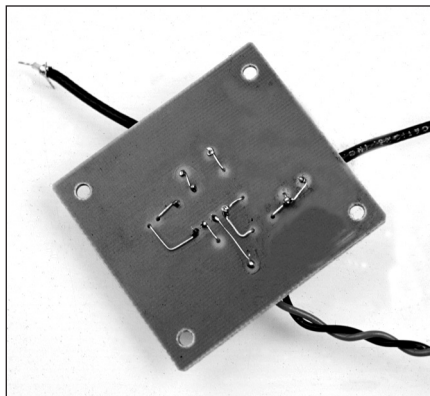


Fig 23.12 — The audio amplifier built using wired-traces construction.

of wire instead of etched traces (Fig 23.12).

To transfer an existing board layout, make a 1:1 photocopy and tape it to your piece of PC board. Prick through the holes with an automatic (one-handed) center punch or by firm pressure with a sharp scribe, remove the photocopy and drill all the holes. Holes for ground leads are optional — you generally get a better RF ground by bending the component lead flat to the board and soldering it down. Remove the copper around the rest of the holes by pressing a drill bit lightly against the hole and twisting it between your fingers. A drill press can also be used, but either way, don't remove too much board material. Then wire up the circuit beneath the board. The results look very neat and tidy — from the top, at least!

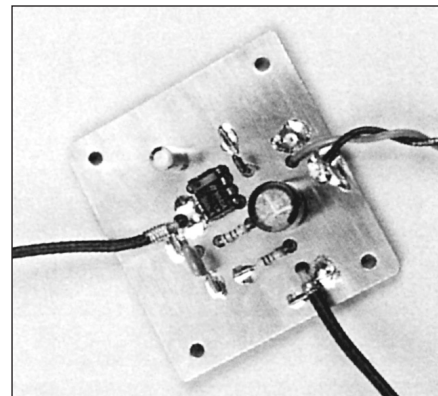
Circuits that contain components originally designed for PC-board mounting are good candidates for this technique. Wired traces would also be suitable for circuits involving multi-pin RF ICs, double-balanced mixers and similar components. To bypass the pins of these components to ground, connect a miniature ceramic capacitor on the bottom of the board directly from the bypassed pin to the ground plane.

A wired-trace board is fairly sturdy, even though many of the components are only held in by their bent leads and blobs of solder. A drop of cyanoacrylate "super glue" can hold down any larger components, components with fragile leads or any long leads or wires that might move.

PERFORATED CONSTRUCTION BOARD

A simple approach to circuit building uses a perforated phenolic or epoxy resin board known as perfboard. Perfboard is available with many different hole patterns. Choose the one that suits your needs. Perfboard is usually unclad, although it is made with pads that facilitate soldering.

Circuit construction on perforated board is easy. Start by placing the components loosely



on the board and moving them around until a satisfactory layout is obtained. Most of the construction techniques described in this chapter can be applied to perfboard. The audio amplifier of Fig 23.9 is shown constructed with this technique in Fig 23.13.

Perfboard and accessories are widely available. Accessories include mounting hardware and a variety of connection terminals for solder and solderless construction.

TERMINAL AND WIRE

A perfboard is usually used for this technique. Push terminals are inserted into the hole in a perfboard. Components can then be easily soldered to the terminals. As an alternative, drill holes into a bare or copper-clad board wherever they are needed (Fig 23.14). The components are usually mounted on one side of the board and wires are soldered to the bottom of the board, acting as wired PC-board "traces." If a component has a reasonably rigid lead to which you can attach other components, use that instead of a push terminal — a modification of the ground-plane construction technique.

If you are using a bare board to provide a ground plane, drill holes for your terminals with a high-speed PC-board drill and drill press. Mark the position of the hole with a center punch to prevent the drill from skidding. The hole should provide a snug fit for the push terminal.

Mount RF components on top of the board, keeping the dc components and much of the interconnecting wiring underneath. Make dc feed-through connections with terminals having bypass capacitors on top of the board. Use small solder-in feedthrough capacitors for more critical applications.

SOLDERLESS PROTOTYPE BOARD

One construction alternative that works well for audio and digital circuits is the solderless prototype board (protoboard), shown in Fig 23.15. It is usually not suitable for RF circuits above a few MHz.

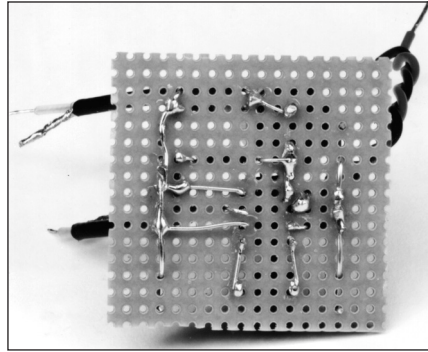
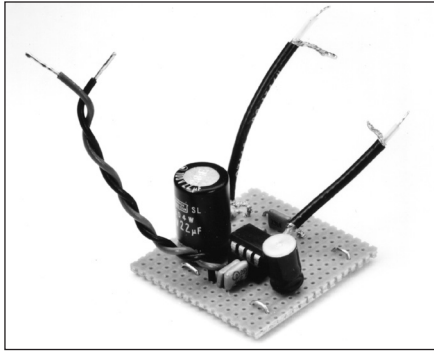


Fig 23.13 — The audio amplifier built on perforated board. Top view at left; bottom view at right.

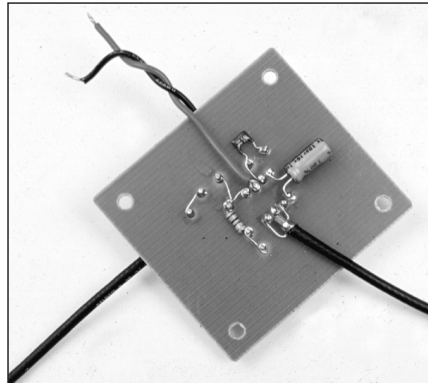
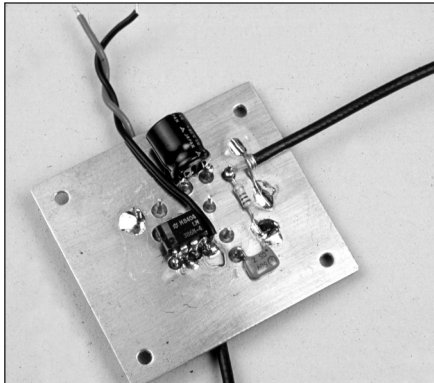


Fig 23.14 — The audio amplifier built using terminal-and-wire construction.

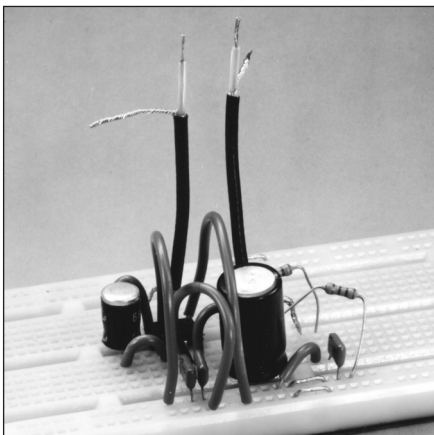


Fig 23.15 — The audio amplifier built on a solderless prototyping board.

A protoboard has rows of holes with spring-loaded metal strips inside the board. Circuit components and hookup wire are inserted into the holes, making contact with the metal strips. Components that are inserted into the same row are connected together. Component and interconnection changes are easy to make. Pre-made and color-coded

jumpers make wiring these boards easier. (A length of phone system cable with four solid-conductor wires makes an excellent source of colored jumper wire.) Look for a protoboard that has power supply terminals already mounted on them for easier connection.

Protoboards have some minor disadvantages. The metal strips add stray capacitance to the circuit and jumper lengths can be long. Large-diameter component leads can deform the metal contacts of the strips — be sure to insert wire no larger than the manufacturer recommends.

WIRE-WRAP CONSTRUCTION

Wire-wrap techniques can be used to quickly construct a circuit without solder. Low- and medium-speed digital circuits are often assembled on a wire-wrap board. The technique is not limited to digital circuits, however. Fig 23.16 shows the audio amplifier built using wire wrap. Circuit changes are easy to make, yet the method is suitable for permanent assemblies.

Wire wrap is done by wrapping a wire around a small square post to make each connection. A wrapping tool resembles a thick pencil. Electric wire-wrap guns are convenient when many connections must be made.

Fig 23.16 — The audio amplifier built using wire-wrap techniques.

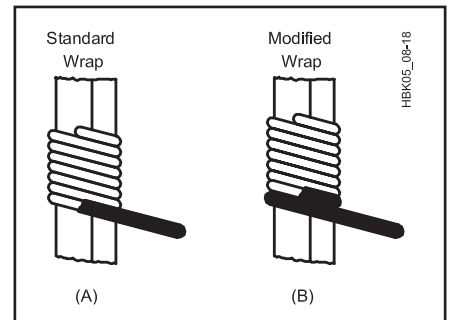
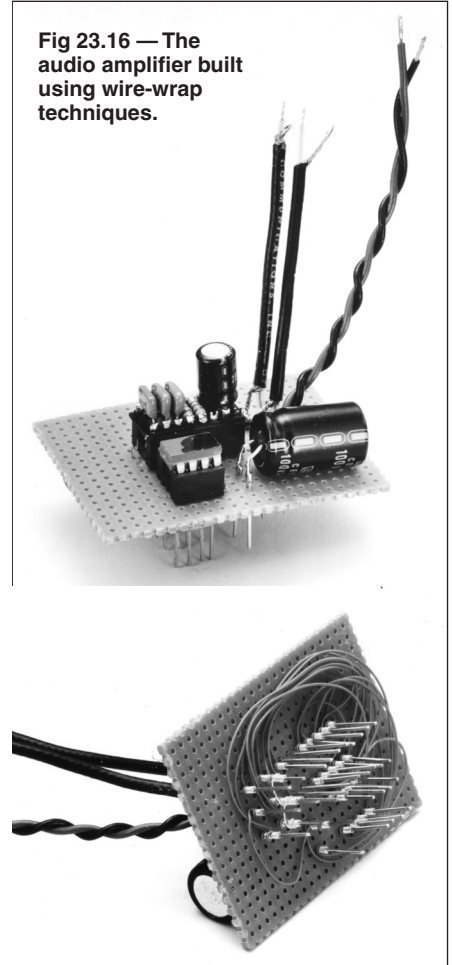


Fig 23.17 — Wire-wrap connections. Standard wrap is shown at A; modified wrap at B.

The wire is almost always #30 AWG wire with thin insulation. Two wire-wrap methods are used: the standard and the modified wrap (Fig 23.17). The modified wrap adds a turn of insulated wire which provides a bit of stress relief to the connection. The wrap-post terminals are square (wire wrap works only on posts with sharp corners). They should be long enough for at least two connections. Fig 23.17 and Fig 23.18 show proper and improper wire-wrap techniques. Mount small components

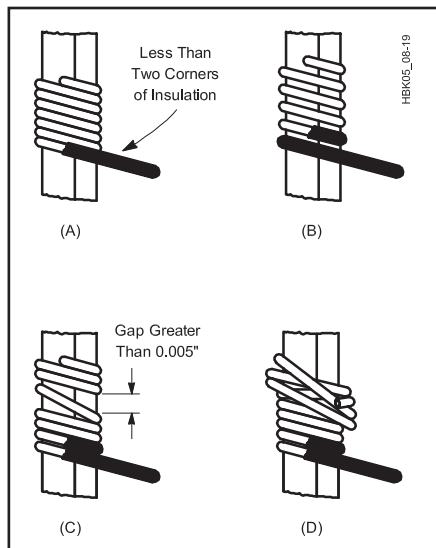


Fig 23.18 — Improper wire-wrap connections. Insufficient insulation for modified wrap is shown at A; a spiral wrap at B, where there is too much space between turns; an open wrap at C, where one or more turns are improperly spaced and an overwrap at D, where the turns overlap on one or more turns.

on an IC header plug. Insert the header into a wire-wrap IC socket as shown in Fig 23.16. The large capacitor in that figure has its leads soldered directly to wire-wrap posts.

“READY-MADE” UTILITY PC BOARDS

“Utility” PC boards are an alternative to custom-designed etched PC boards. They offer the flexibility of perforated board construction and the mechanical and electrical advantages of etched circuit connection pads. Utility PC boards can be used to build anything from simple passive filter circuits to computers.

Circuits can be built on boards on which the copper cladding has been divided into connection pads. Power supply voltages can

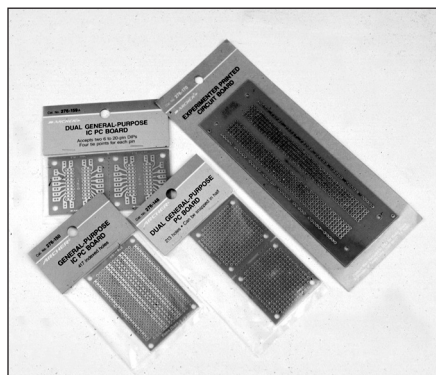


Fig 23.19 — Utility PC boards like these are available from many suppliers.

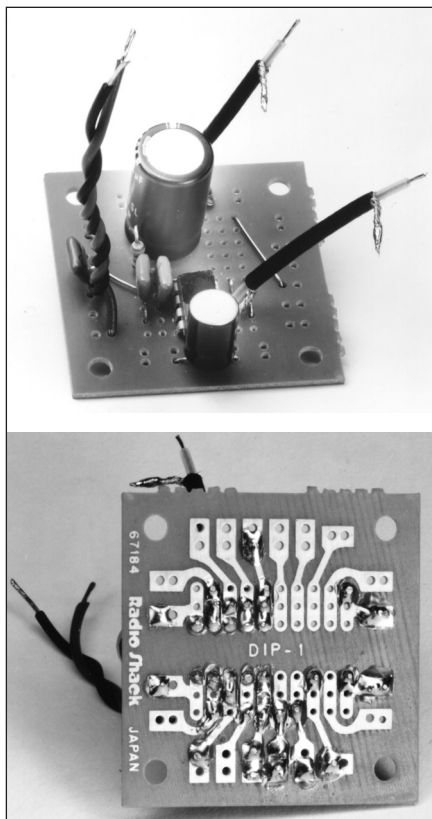


Fig 23.20 — The audio amplifier built on a multipurpose PC breadboard. Top view at A; bottom view at B.

be distributed on bus strips. Boards like those shown in Fig 23.19 are commercially available.

An audio amplifier constructed on a utility PC board is shown in Fig 23.20. Component leads are inserted into the board and soldered to the etched pads. Wire jumpers connect the pads together to complete the circuit.

Utility boards with one or more etched plugs for use in computer-bus, interface and general purpose applications are widely available. Connectors, mounting hardware and other accessories are also available. Check with your parts supplier for details.

23.5.6 Printed-Circuit (PC) Boards

PC boards are everywhere — in all kinds of consumer electronics, in most of your Amateur Radio equipment. They are also used in most kits and construction projects. A newcomer to electronics might think that there is some unwritten law against building equipment in any other way!

The misconception that everything needs to be built on a printed-circuit board is often a stumbling block to easy project construction. In fact, a PC board is probably the worst

choice for a one-time project. In actuality, a moderately complex project (such as a QRP transmitter) can be built in much less time using other techniques such as those described in the preceding section. The additional design, layout and manufacturing is usually much more work than it would take to build the project by hand.

So why does everyone use PC boards? The most important reason is that they are reproducible. They allow many units to be mass-produced with exactly the same layout, reducing the time and work of conventional wiring and minimizing the possibilities of wiring errors. If you can buy a ready-made PC board or kit for your project, it can save a lot of construction time. This is true because someone else has done most of the real work involved — designing the PC board layout and fixing any “bugs” caused by inter-trace capacitive coupling, ground loops and similar problems. In most cases, if a ready-made board is not available, ground-plane construction is a lot less work than designing, debugging and then making a PC board.

Using a PC board usually makes project construction easier by minimizing the risk of wiring errors or other construction blunders. Inexperienced constructors usually feel more confident when construction has been simplified to the assembly of components onto a PC board. One of the best ways to get started with home construction (to some the best part of Amateur Radio) is to start by assembling a few kits using PC boards. A list of kit manufacturers can be found on the QRP ARCI website, www.qrparci.org, under “Links.” Then click on “QRP Kits and Components”.

ON-LINE PC BOARD FABRICATION SERVICES

In the past few years, on-line PC board fabrication services have become popular among hobbyists and professional designers. See the **Computer-Aided Circuit Design** chapter for a discussion of PCB design software and services. These services specialize in fast turnaround (two or three days, typically) of small boards in low quantities. Some accept artwork files in standard interchange formats and others have proprietary software packages. The cost per board is quite reasonable, considering the expense of maintaining the tools and techniques needed to construct boards in a home shop. The results are professional and high-quality.

PC-BOARD ASSEMBLY TECHNIQUES

Cleanliness

Make sure your PC board and component leads are clean. Clean the entire PC board before assembly; clean each component before you install it. Corrosion looks dark instead

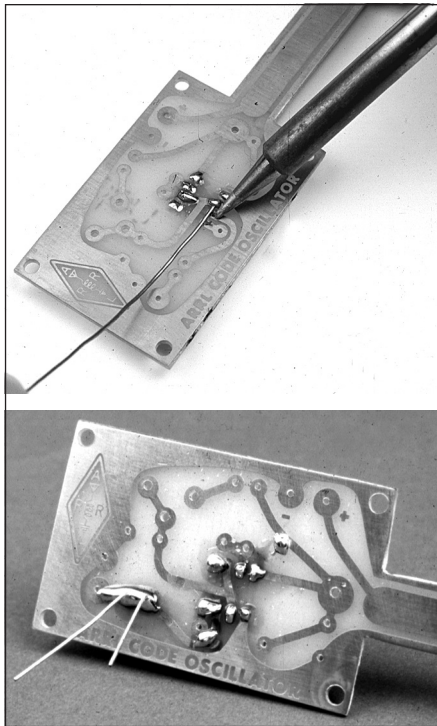


Fig 23.21 — The top photo shows how to solder a component to a PC board. Make sure that the component is flush with the board on the other side. Below is a solder bridge has formed a short circuit between PC board traces.

of bright and shiny. Don't use sandpaper to clean your board. Use a piece of fine steel wool or a Scotchbrite cleaning pad to clean component leads or PC board before you solder them together.

Installing Components

In a construction project that uses a PC board, most of the components are installed on the board. Installing components is easy — stick the components in the right board holes, solder the leads, and cut off the extra lead length. Most construction projects have a parts-placement diagram that shows you where each component is installed.

Getting the components in the right holes is called “stuffing” the circuit board. Inserting and soldering one component at a time takes too long. Some people like to put the components in all at once, and then turn the board over and solder all the leads. If you bend the leads a bit (about 20°) from the bottom side after you push them through the board, the components are not likely to fall out when you turn the board over.

Start with the shortest components — horizontally mounted diodes and resistors. Larger components sometimes cover smaller components, so these smaller parts must be installed first. If building a kit, follow the suggested

order of mounting your parts if provided. Use adhesive tape to temporarily hold difficult components in place while you solder.

PC-Board Soldering

To solder components to a PC board, bend the leads at a slight angle; apply the soldering iron to one side of the lead, and flow the solder in from the other side of the lead. See **Fig 23.21A**. Too little heat causes a bad or “cold” solder joint; too much heat can damage the PC board. Practice a bit on some spare copper stock before you tackle your first PC board project. After the connection is soldered properly, clip the lead flush with the solder.

Make sure you have the components in the right holes before you solder them. Components that have polarity, such as diodes, ICs and some capacitors must be oriented as shown on the parts-placement diagram.

Inspect solder connections. A bad solder joint is much easier to find before the PC board is mounted to a chassis. Look for any damage caused to the PC board by soldering. Look for solder “bridges” between adjacent circuit-board traces. Solder bridges (**Fig 23.21B**) occur when solder accidentally connects two or more conductors that are supposed to be isolated. It is often difficult to distinguish a solder bridge from a conductive trace on a tin-plated board. If you find a bridge, re-melt it and the adjacent trace or traces to allow the solder's surface tension to absorb it. Double check that each component is installed in the proper holes on the board and that the orientation is correct. Make sure that no component leads or transistor tabs are touching other components or PC board connections. Check the circuit voltages before installing ICs in their sockets. Ensure that the ICs are oriented properly and installed in the correct sockets.

23.5.7 From Schematic to Working Circuit

Turning a schematic into a working circuit is more than just copying the schematic with components. One thing is usually true — you can't build it the way it looks on the schematic. The schematic describes the electrical connections, but it does not describe the mechanical layout of the circuit. Many design and layout considerations that apply in the real world of practical electronics don't appear on the schematic.

HOW TO DESIGN A GOOD CIRCUIT LAYOUT

A circuit diagram is a poor guide toward a proper layout. Circuit diagrams are drawn to be readable and to describe the electrical connections. They follow drafting conven-

tions that have very little to do with the way the circuit works. On a schematic, ground and supply voltage symbols are scattered all over the place. The first rule of RF layout is — *do not layout RF circuits as their schematics are drawn!* How a circuit works in practice depends on the layout. Poor layout can ruin the performance of even a well-designed circuit.

The easiest way to explain good layout practices is to take you through an example. **Fig 23.22** is the circuit diagram of a two-stage receiver IF amplifier using dual-gate MOSFETs. It is only a design example, so the values are only typical. To analyze which things are important to the layout of this circuit, ask these questions:

- Which are the RF components, and which are only involved with AF or dc?
- Which components are in the main RF signal path?
- Which components are in the ground return paths?

Use the answers to these questions to plan the layout. The RF components that are in the main RF signal path are usually the most critical. The AF or dc components can usually be placed anywhere. The components in the ground return path should be positioned so they are easily connected to the circuit ground. Answer the questions, apply the answers to the layout and then follow these guidelines:

- Avoid laying out circuits so their inputs and outputs are close together. If a stage's output is too near a previous stage's input, the output signal can feedback into the input and cause problems.
- Keep component leads as short as practical. This doesn't necessarily mean as short as possible, just consider lead length as part of your design.
- Remember that metal transistor cases conduct, and that a transistor's metal case is usually connected to one of its leads. Prevent cases from touching ground or other components, unless called for in the design.

In our design example, the RF components are shown in heavy lines, though not all of these components are in the main RF signal path. The RF signal path consists of T1/C1, Q1, T2/C4, C7, Q2, T3/C11. These need to be positioned in almost a straight line, to avoid feedback from output to input. They form the backbone of the layout, as shown in **Fig 23.23A**.

The question about ground paths requires some further thought — what is really meant by “ground” and “ground-return paths”? Some points in the circuit need to be kept at RF ground potential. The best RF ground potential on a PC board is a copper ground plane covering one entire side. Points in the circuit that cannot be connected directly to ground for dc reasons must be bypassed (“decoupled”) to ground by capacitors that

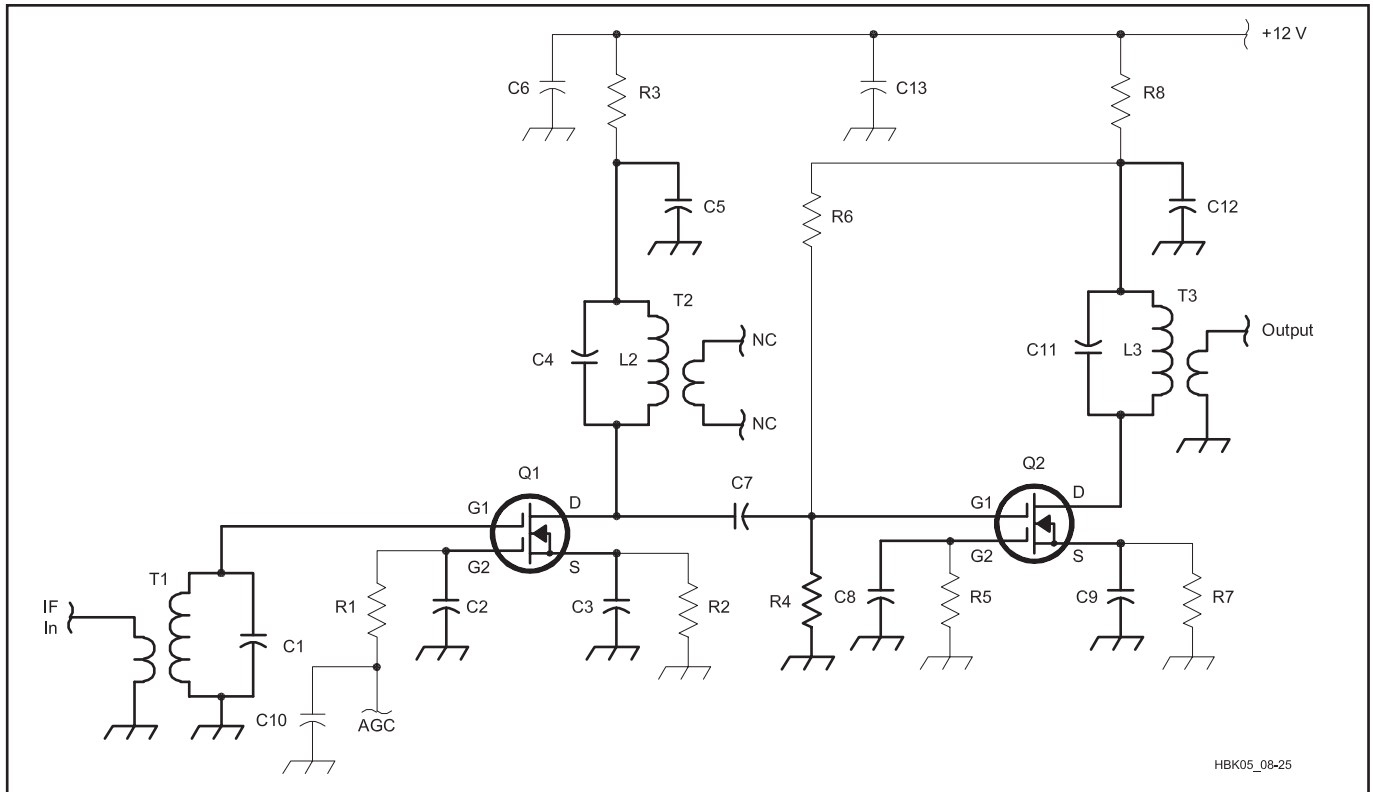


Fig 23.22 — The IF amplifier used in the design example. C1, C4 and C11 are not specified because they are internal to the IF transformers.

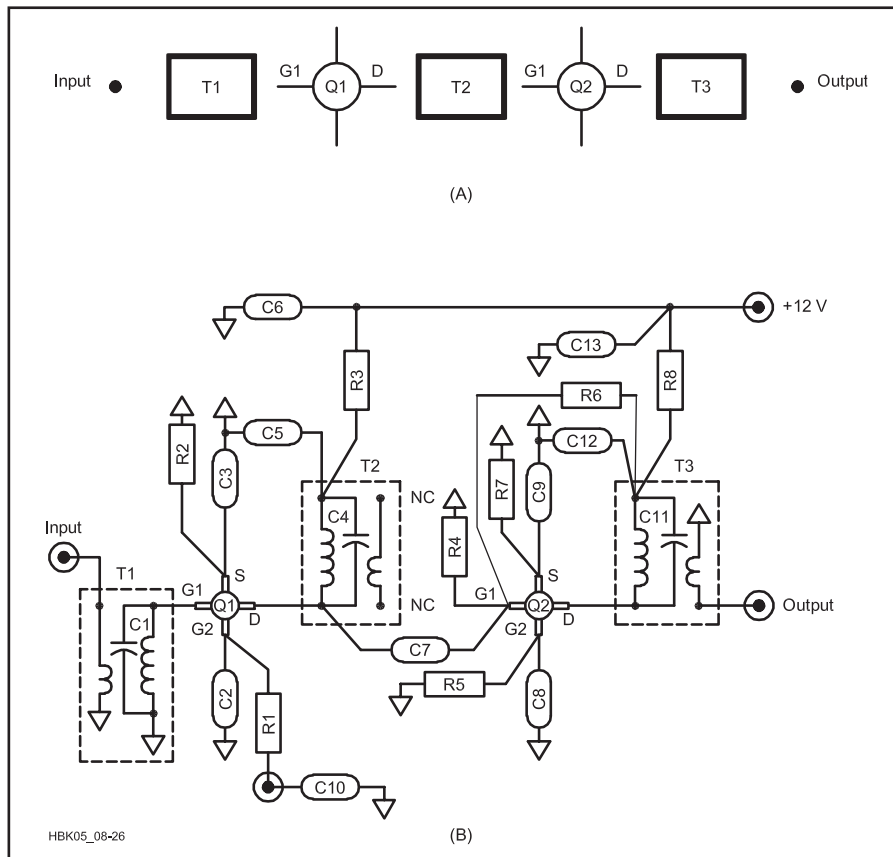


Fig 23.23 — Layout sketches. The preliminary line-up is shown in A; the final layout in B.

provide ground-return paths for RF.

In Fig 23.23, the components in the ground-return paths are the RF bypass capacitors C2, C3, C5, C8, C9 and C12. R4 is primarily a dc biasing component, but it is also a ground return for RF so its location is important. The values of RF bypass capacitors are chosen to have a low reactance at the frequency in use; typical values would be 0.1 μF at LF, 0.01 μF at HF and 0.001 μF or less at VHF. Not all capacitors are suitable for RF decoupling; the most common are disc ceramic capacitors. RF decoupling capacitors should always have short leads. Surface mount capacitors with no leads are ideal for bypassing.

Almost every RF circuit has an input, an output and a common ground connection. Many circuits also have additional ground connections, both at the input side and at the output side. Maintain a low-impedance path between input and output ground connections. The input ground connections for Q1 are the grounded ends of C1 and the two windings of T1. The two ends of an IF transformer winding are generally not interchangeable; one is designated as the “hot” end, and the other must be connected or bypassed to RF ground.) The capacitor that resonates with the adjustable coil is often mounted inside the can of the IF transformer, leaving only two component leads to be grounded as shown in Fig 23.22B.

The RF ground for Q1 is its source connection via C3. Since Q1 is in a plastic package that can be mounted in any orientation, you can make the common ground either above or below the signal path in Fig 23.23B, although the circuit diagram shows the source at the bottom. The practical circuit works much better with the source at the top, because of the connections to T2.

It's a good idea to locate the hot end of the main winding close to the drain lead of the transistor package, so the other end is toward the top of Fig 23.23B. If the source of Q1 is also toward the top of the layout, there is a common ground point for C3 (the source bypass capacitor) and the output bypass capacitor C5. Gate 2 of Q1 can safely be bypassed toward the bottom of the layout.

C7 couples the signal from the output of Q1 to the input of Q2. The source of Q2 should be bypassed toward the top of the layout, in exactly the same way as the source of Q1. R4 is not critical, but it should be connected on the same side as the other components. Note how the pinout of T3 has placed the output connection as far as possible from the input. With this layout for the signal path and the critical RF components, the circuit has an excellent chance of working properly.

DC Components

The rest of the components carry dc, so their layout is much less critical. Even so, try to keep everything well separated from the main RF signal path. One good choice is to put the 12 V connections along the top of the layout, and the AGC connection at the bottom. The source bias resistors R2 and R7 can be placed alongside C3 and C9. The gate-2 bias resistors for Q2, R5 and R6 are not RF components so their locations aren't too critical. R7 has to cross the signal path in order to reach C12, however, and the best way to avoid signal pickup would be to mount R7 on the opposite side of the copper ground plane from the signal wiring. Generally speaking, $\frac{1}{8}$ W or $\frac{1}{4}$ W metal-film or carbon-film resistors are best for low-level RF circuits.

Actually, it is not quite accurate to say that resistors such as R3 and R8 are not "RF" components. They provide a high impedance to RF in the positive supply lead. Because of R8, for example, the RF signal in T2 is conducted to ground through C5 rather than ending up on the 12 V line, possibly causing unwanted RF feedback. Just to be sure, C6 bypasses R3 and C13 serves the same function for R8. Note that the gate-1 bias resistor R6 is connected to C12 rather than directly to the 12 V supply, to take advantage of the extra decoupling provided by R8 and C13.

If you build something, you want it to work the first time, so don't cut corners! Some commercial PC boards take liberties with layout, bypassing and decoupling. Don't as-

sume that you can do the same. Don't try to eliminate "extra" decoupling components such as R3, C6, R8 and C13, even though they might not all be absolutely necessary. If other people's designs have left them out, put them in again. In the long run it's far easier to take a little more time and use a few extra components, to build in some insurance that your circuit will work. For a one-time project, the few extra parts won't hurt your pocket too badly; they may save untold hours in debugging time.

A real capacitor does not work well over a large frequency range. A 10- μ F electrolytic capacitor cannot be used to bypass or decouple RF signals. A 0.1- μ F capacitor will not bypass UHF or microwave signals. Choose component values to fit the range. The upper frequency limit is limited by the series inductance, L_s . In fact, at frequencies higher than the frequency at which the capacitor and its series inductance form a resonant circuit, the capacitor actually functions as an inductor. This is why it is a common practice to use two capacitors in parallel for bypassing, as shown in Fig 23.24. At first glance, this might appear to be unnecessary. However, the self-resonant frequency of C1 is usually 1 MHz

or less; it cannot supply any bypassing above that frequency. However, C2 is able to bypass signals up into the lower VHF range. (This technique should not be applied under all circumstances as discussed in the section on Bypassing in the **RF Techniques** chapter.)

Let's summarize how we got from Fig 23.22 to Fig 23.23B:

- Lay out the signal path in a straight line.
- By experimenting with the placement and orientation of the components in the RF signal path, group the RF ground connections for each stage close together, without mixing up the input and output grounds.
- Place the non-RF components well clear of the signal path, freely using decoupling components for extra measure.

Practical Construction Hints

Now it's time to actually construct a project. The layout concepts discussed earlier can be applied to nearly any construction technique. Although you'll eventually learn from your own experience, the following guidelines give a good start:

- Divide the unit into modules built into separate shielded enclosures — RF, IF, VFO, for example. Modular construction improves

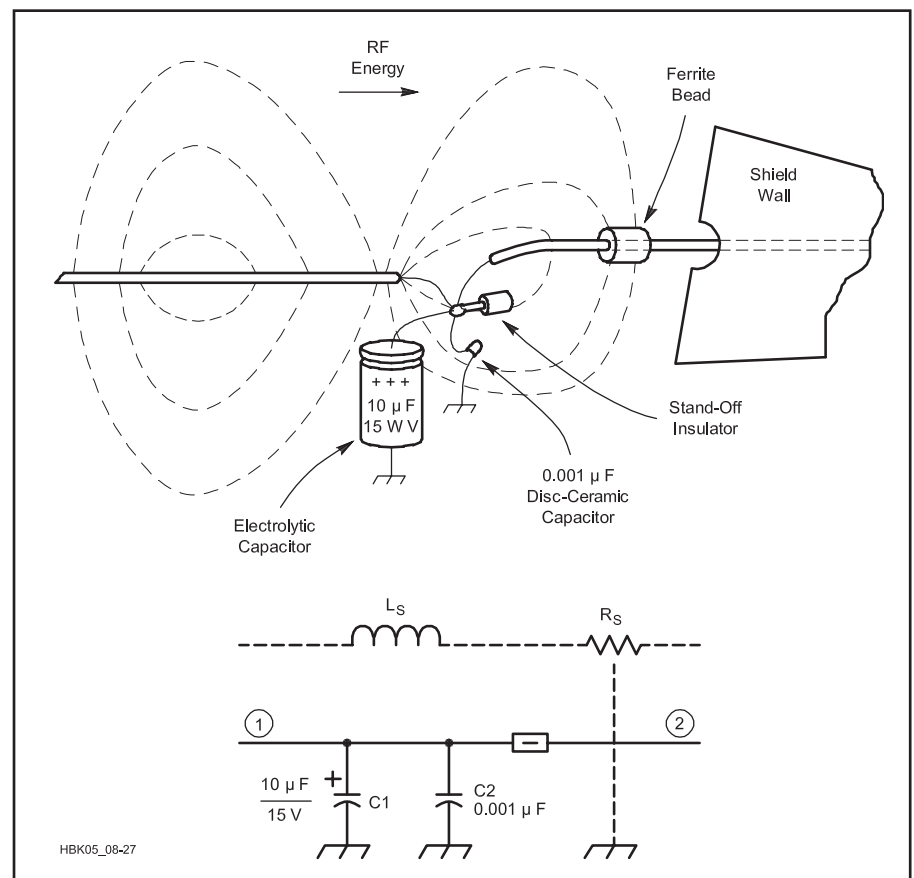


Fig 23.24 — Two capacitors in parallel afford better bypassing across a wide frequency range.

RF stability, and makes the individual modules easier to build and test. It also means that you can make major changes without rebuilding the whole unit. RF signals between the modules can usually be connected using small coaxial cable.

- Use a full copper ground plane. This is your largest single assurance of RF stability and good performance.

- Keep inputs and outputs well separated for each stage, and for the whole unit. If possible, lay out all stages in a straight line. If an RF signal path doubles back or re-crosses itself it usually results in instability.

- Keep the stages at different frequencies well-separated to minimize interstage coupling and spurious signals.

- Use interstage shields where necessary, but don't rely on them to cure a bad layout.

- Make all connections to the ground plane short and direct. Locate the common ground for each stage between the input and the output ground. Single-point grounding may work for a single stage, but it is rarely effective in a complex RF system.

- Locate frequency-determining components away from heat sources and mount them so as to maximize mechanical strength.

- Avoid unwanted coupling between tuned circuits. Use shielded inductors or toroids rather than open coils. Keep the RF high-voltage points close to the ground plane. Orient air-wound coils at right angles to minimize mutual coupling.

- Use lots of extra RF bypassing, especially on dc supply lines.

- Try to keep RF and dc wiring on opposite sides of the board, so the dc wiring is well away from RF fields.

- Compact designs are convenient, but don't overdo it! If the guidelines cited above mean that a unit needs to be bigger, make it bigger.

COMBINING TECHNIQUES

You can use a mixture of construction techniques on the same board and in most cases you probably should. Even though you choose one style for most of the wiring, there will probably be places where other techniques would be better. If so, do whatever is best for that part of the circuit. The resulting hybrid may not be pretty (these techniques aren't called "ugly construction" for nothing), but it will work!

Mount dual-in-line package (DIP) ICs in an array of drilled holes, then connect them using wired traces as described earlier. It is okay to mount some of the components using a ground-plane method, push pins or even wire wrap. On any one board, you may use a combination of these techniques, drilling holes for some ICs, or gluing others upside down, then surface mounting some of the pins, and other techniques to connect the

rest. These combination techniques are often found in a project that combines audio, RF and digital circuitry.

A Final Check

No matter what construction technique is chosen, do a final check before applying power to the circuit! Things do go wrong, and a careful inspection minimizes the risk of a project beginning and ending its life as a puff of smoke! Check wiring carefully. Make a photocopy of the schematic and mark each connection and lead on the schematic with a red X or use highlighter to mark the circuit when you've verified that it's connected properly.

23.5.8 Other Construction Techniques

WIRING

Select the wire used in connecting amateur equipment by considering: the maximum current it must carry, the voltage its insulation must withstand and its use.

To minimize leakage of RF that causes EMI, the power wiring and low-level signal wiring of all transmitters should use shielded wire or coaxial cable. Receiver and audio circuits may also require the use of shielded wire at some points for stability or the elimination of coupling to adjacent circuits. Coaxial cable is recommended for all 50 Ω circuits. It can also be used for *short* runs of high-impedance audio wiring.

When choosing wire, consider how much current it will carry. (See the Copper Wire Specifications table in the **Component Data and References** chapter for maximum current-carrying capability, called *ampacity*.) Stranded wire is usually preferred over solid wire because stranded wire better withstands the inevitable bending that is part of building and troubleshooting a circuit. Solid wire is more rigid than stranded wire; use it where mechanical rigidity is needed or desired.

Wire with typical plastic insulation is good for voltages up to about 500 V. Use Teflon-insulated or other high-voltage wire for higher voltages. Teflon insulation does not melt when a soldering iron is applied. This makes it particularly helpful in tight places or large wiring harnesses. Although Teflon-insulated wire is more expensive, it is often available from industrial surplus houses.

Solid wire is often used to wire RF circuits in both receivers and transmitters. Bare soft-drawn tinned wire, #22 to #12 AWG (depending on mechanical requirements) is suitable. Avoid kinks by stretching a piece 10 or 15 feet long and then cutting it into short, convenient lengths. Run RF wiring directly from point to point with a minimum of sharp bends and keep the wire well-spaced from the chassis or other grounded metal surfaces. Where the wiring must pass through a chassis wall or

shield, cut a clearance hole and line it with a rubber grommet. If insulation is necessary, slip spaghetti insulation or heat-shrink tubing over the wire. For power-supply leads, bring the wire through walls or barriers via a feedthrough capacitor.

In transmitters where the peak voltage does not exceed 500 V, shielded wire is satisfactory for power circuits. Shielded wire is not readily available for higher voltages — use point-to-point wiring instead. In the case of filament circuits carrying heavy current, it is necessary to use #10 or #12 AWG bare or enameled wire. Slip the bare wire through spaghetti then cover it with copper braid pulled tightly over the spaghetti. Slide the shielding back over the insulation and flow solder into the end of the braid; the braid will stay in place, making it unnecessary to cut it back or secure it in place. Clean the braid first so solder will flow into the braid with a minimum of heat.

ENAMELED WIRE

When connecting enameled wire leads, care must be taken to be sure a good connection is made. There are two methods that can be used to remove the insulation. With Thermaleze-type enamel, the heat from a soldering iron can be used to remove the insulation. You will first need to turn up the heat on your soldering iron for best results. After adding some melted solder to your soldering tip, move the drop slowly along the desired length of the wire lead. Moving it slowly gives the insulation time to melt and the solder a chance to tin the now-exposed wire. The tinned leads will then easily solder to a PC board or other mounting system.

If using other kinds of enameled wire, an emery board or small file can be used to remove the insulation. (Using a knife to scrape off the enamel usually nicks the wire which will eventually break at that point.) Be sure you have removed it completely from the desired lead. Follow that up with your soldering iron and solder to tin the wire using a thin coating of solder. Be sure to not make the tinned surface so thick that the lead cannot fit through the PC board holes. Preparing the leads in this manner will give the best possibility for a clean and secure connection.

HIGH-VOLTAGE TECHNIQUES

High-voltage wiring and construction requires special care. Read and follow the guidelines for high-voltage construction in the **Power Sources** chapter. You must use wire with insulation rated for the voltage it is carrying. Most standard hookup wire is inadequate above 300 or 600 V. High-voltage wire is usually insulated with Teflon or special multilayer plastic. Some coaxial cable is rated at 3700 V_{RMS} (or more) *internally* between the center conductor and shield but the outer jacket rating is usually considerably lower.

CABLE ROUTING

Where power or control leads run together for more than a few inches, they present a better appearance when bound together in a single cable. Plastic cable ties or tubing cut into a spiral are used to restrain and group wiring. Check with your local electronic parts supplier for items that are in stock.

To give a commercial look to the wiring of any unit, route any dc leads and shielded signal leads along the edge of the chassis. If this isn't possible, the cabled leads should then run parallel to an edge of the chassis. Further, the generous use of the tie points mounted parallel to an edge of the chassis, for the support of one or both ends of a resistor or fixed capacitor, adds to the appearance of the finished unit. In a similar manner, arrange the small components so that they are parallel to the panel or sides of the chassis.

Tie Points

When power leads have several branches in the chassis, it is convenient to use fiber-insulated terminal strips as anchors for junction points. Strips of this kind are also useful as insulated supports for resistors, RF chokes and capacitors. Hold exposed points of high-voltage wiring to a minimum; otherwise, make them inaccessible to accidental contact.

WINDING COILS

A detailed tutorial for winding coils by Robert Johns, W3JIP, titled "Homebrew Your Own Inductors!" from August 1997 *QST* can be found in the Radio Technology section of the ARRL TIS at www.arrl.org/radio-technology-topics under Circuit Construction. Understanding these techniques greatly simplifies coil construction.

Close-wound coils are readily wound on the specified form by anchoring one end of the length of wire (in a vise or to a doorknob) and the other end to the coil form. Straighten any kinks in the wire and then pull to keep the wire under slight tension. Wind the coil to the required number of turns while walking toward the anchor, always maintaining a slight tension on the wire.

To space-wind the coil, wind the coil simultaneously with a suitable spacing medium (heavy thread, string or wire) in the manner described above. When the winding is complete, secure the end of the coil to the coil-form terminal and then carefully unwind the spacing material. If the coil is wound under suitable tension, the spacing material can be easily removed without disturbing the winding. Finish space-wound coils by judicious applications of RTV sealant or hot-melt glue to hold the turns in place.

The "cold" end of a coil is the end at (or close to) chassis or ground potential. Wind coupling links on the cold end of a coil to minimize capacitive coupling.

Winding Toroidal Inductors

Toroidal inductors and transformers are specified for many projects in this *Handbook*. The advantages of these cores include compactness and a self-shielding property. **Figs 23.25 and 23.26** illustrate the proper way to wind and count turns on a toroidal core.

The task of winding a toroidal core, when more than just a few turns are required, can be greatly simplified by the use of a homemade bobbin upon which the wire is first wound. A simple yet effective bobbin can be fashioned

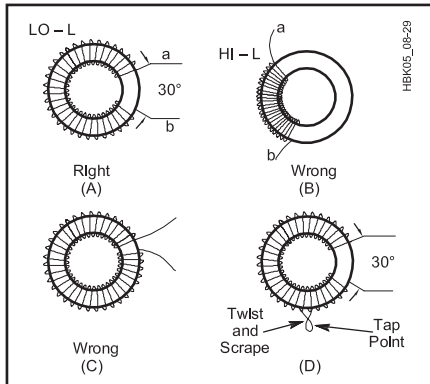


Fig 23.25 — The maximum-Q method for winding a single-layer toroid is shown at A. A 30° gap is best. Methods at B and C have greater distributed capacitance. D shows how to place a tap on a toroidal coil winding.

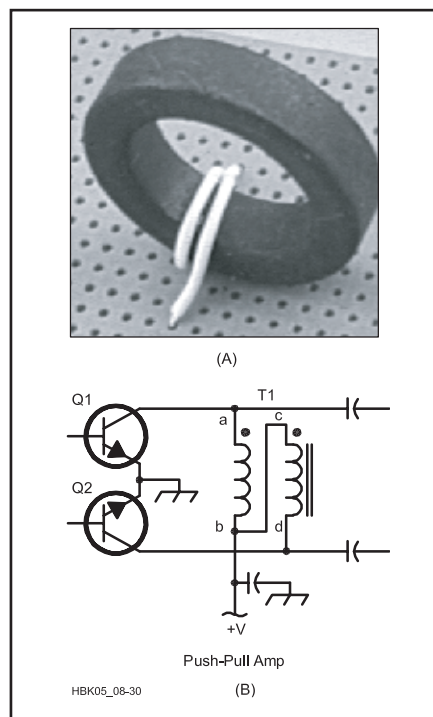


Fig 23.26 — A shows a toroidal core with two turns of wire (see text). Large black dots, like those at T1 in B, indicate winding polarity (see text).

from a wooden popsicle stick. Cut a "V" notch at each end and first wind the wire coil on the popsicle stick lengthwise through the notches. Once this is done, the wound bobbin can be easily passed through the toroid's inside diameter. While firmly grasping one of the wire ends against the toroidal core, the bobbin can be moved up, around, and through the toroidal core repeatedly until the wire has been completely transferred from the bobbin. The choice of bobbin used is somewhat dependent on the inside diameter of the toroid, the wire size, and the number of turns required.

Another method is to create a holder that allows you to grip the core, yet thread the wire easily around it. When winding toroids, be sure to seat the wire so it hugs the shape of the core and do not allow turns to overlap unless part of a twisted group of wires as in bifilar or trifilar windings. Do not pull the wire too tight as the thin wire used in some toroids can break if pulled too tightly.

When you wind a toroid inductor, count each pass of the wire through the toroid center as a turn. You can count the number of turns by counting the number of times the wire passes through the center of the core. See Fig 23.26A.

Multiwire Windings

A bifilar winding is one that has two identical lengths of wire, which when placed on the core result in the same number of turns for each wire. The two wires are wound on the core side by side at the same time, just as if a single winding were being applied. An easier and more popular method is to twist the two wires (8 to 15 turns per inch is adequate), then wind the twisted pair on the core. The wires can be twisted handily by placing one end of each in a bench vise. Tighten the remaining ends in the chuck of a small hand drill and turn the drill to twist the pair.

A trifilar winding has three wires, and a quadrifilar winding has four. The procedure

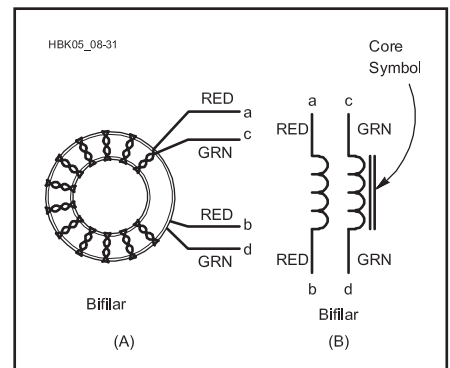


Fig 23.27 — Schematic and pictorial presentation of a bifilar-wound toroidal transformer.

for preparation and winding is otherwise the same as for a bifilar winding. Fig 23.27 shows a bifilar toroid in schematic and pictorial form. The wires have been twisted together prior to placing them on the core. It is helpful, though by no means essential, to use wires of different color for multifilar windings. It is more difficult to identify multiple windings on a core after it has been wound. Various colors of enamel insulation are available, but it is not easy for amateurs to find this wire locally or in small-quantity lots. This problem can be solved by taking lengths of

wire (enameled magnet wire), cleaning the ends to remove dirt and grease, then spray painting them. Ordinary aerosol-can spray enamel works fine. Spray lacquer is not as satisfactory because it is brittle when dry and tends to flake off the wire.

You may also identify bifilar and trifilar toroid lead pairs of identical colors by using a continuity checker. It is a good idea to check all toroids with an ohmmeter or continuity tester to be sure there are no shorts between different windings and that there is a good connection on the ends of each winding.

Testing the leads after mounting can be difficult due to the circuit layouts, so be sure to test all toroids before mounting.

The winding sense of a multifilar toroidal transformer is important in most circuits. Fig 23.26B illustrates this principle. The black dots (called phasing dots) at the top of the T1 windings indicate polarity. That is, points a and c are both start or finish ends of their respective windings. In this example, points a and d are of opposite polarity to provide push-pull voltage output from Q1 and Q2.

23.6 Microwave Construction

Paul Wade, W1GHZ, updated this short tutorial to construction practices suitable for microwave frequency operation originally written by ARRL Laboratory Engineer, Zack Lau, W1VT. For more information on microwave equipment, read Paul's series of columns, "Microwavelengths," in *QST*.

Microwave construction is not only fun, but within the capabilities of most amateurs. To get on the air requires some degree of construction, since you can't buy a ready to go box. At a minimum, a few modules must be connected together with coax and power cables. At the other extreme, the whole station may be homebrewed from scratch, or from a kit.

The growth of mobile phones and wireless networking has caused a proliferation of microwave integrated circuits offering high performance at low cost. Some of these are also useful for ham applications, so that microwave construction has evolved from traditional waveguide "plumbing" to printed circuitry requiring surface-mount assembly of tiny components. Waveguide techniques are still valuable for some components, such as filters and antennas, so proficiency in both types of construction is valuable.

A problem we all face when building new microwave equipment is finding a nearby station to try it out. One solution is to convince a buddy to build a similar system, so that you will both have someone to work. If you have complementary skills, say one with metal and the other with surface-mount soldering, you can help each other. A larger group or club effort can be even better — someone with experience and test equipment can be an Elmer for the group.

In addition to the material here and in magazine columns, several excellent references for amateurs interested in working on microwave frequencies include:

- *Microwave Know How*, by Andy Barter, G8ATD (RSGB)
- *International Microwave Handbook*, by

Andy Barter, G8ATD (RSGB)

- *The ARRL UHF/Microwave Experimenter's Manual* (out of print but available used)
- *The ARRL UHF/Microwave Projects CD*

23.6.1 Lead Lengths

Microwave construction is becoming more popular, but at these frequencies the size of physical component leads and PC-board traces cannot be neglected. Microwave construction techniques either minimize these stray values or make them part of the circuit design.

The basic consideration in microwave circuitry is short lead lengths, particularly for ground returns. Current always flows in a complete loop with a return path through the "ground". (See Fig 23.28) The loop must be much smaller than a wavelength for a circuit to work properly — as the frequency gets higher, dimensions must get smaller. One area that requires particular care to ensure good ground return continuity is the transition from coax cable outside a cabinet to a PC board

inside the cabinet.

At microwave frequencies, the mechanical aspects and physical size of circuits become very much a part of the design. A few millimeters of conductor has significant reactance at these frequencies. This even affects VHF and HF designs in which the traces and conductors resonate on microwave frequencies. If a high-performance FET has lots of gain in this region, a VHF preamplifier might also function as a 10 GHz oscillator if the circuit stray reactances were just right (or wrong!). You can prevent this by using shields between the input and output or by adding microwave absorptive material to the lid of the shielded module. (SHF Microwave sells absorptive materials.)

23.6.2 Metalworking

Waveguide construction requires some basic metalworking skills, which are also useful for assembly and packaging of microwave systems. Some minimal tools would be a hacksaw, drills, files, and layout tools.

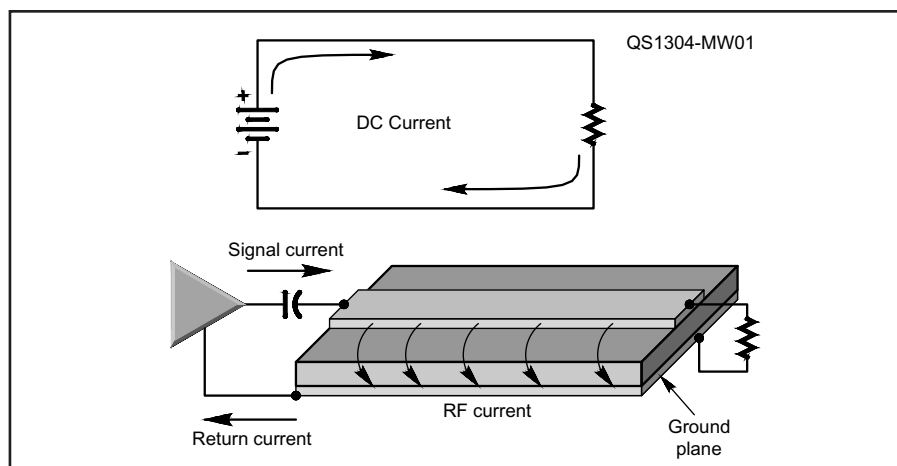


Fig 23.28 — Current must always flow in a complete loop. This is particularly important at microwave frequencies where wavelengths are very short.

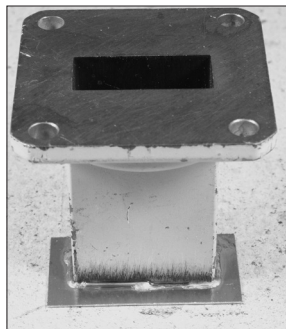
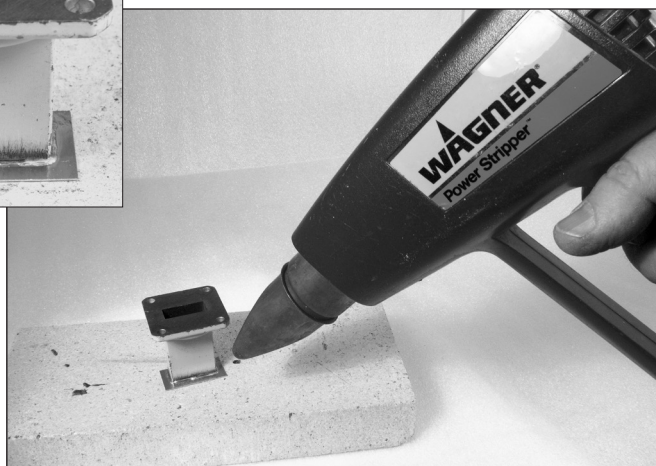


Fig 23.29 — Larger assemblies may be soldered with a heat gun. A torch is better for high-temperature brazing.



While a hand drill can suffice, an inexpensive drill press will make work more precise as well as safer. In metals, Dewalt Pilot Point drill bits make clean, accurate holes. Files and nibbling tools can make rectangular or odd-shaped holes.

Solder has a poor reputation for microwave losses — but, of course, it is essential. It does have higher resistance than copper or aluminum, but that only matters in locations of high current, for instance, the ground end of a high-Q quarter-wave resonator. Horn antennas and most waveguide structures have low Q so a clean solder joint, without excess blobs, has no effect. Traditional tin-lead solder works well; the silver solder with 1% silver has no performance advantage but looks pretty.

For things like waveguide and antennas that are too large for a soldering iron, a hot air gun does an excellent job. **Fig 23.29** shows the backshort of a waveguide transition as it is being soldered with a hot air gun. A small amount of paste flux (Kester SP-44) was applied to the waveguide end, and a ring of solder placed along the joint. Then heat is applied to the whole area until the solder melts and flows into the joint.

A torch can also be used for soldering, but tends to cause more oxidation of the metal. However, when a high-temperature brazed joint is desired, a torch is required. A MAPP gas torch and Silvaloy 15 (or Harris Stay-silv 15) silver brazing material, which requires no flux, are suitable for small and medium-sized components.

Many hams seem to think that silver plating is desirable, but it rarely makes a difference — it just looks much prettier. The only application in which silver plating has been shown to make a significant difference is in UHF cavities with sliding contacts. In most

other places, copper losses are low enough so that little improvement is possible, and aluminum is fine for most uses.

23.6.3 Circuit Construction

Modular construction is a useful technique for microwave circuits. Often, circuits are tested by connecting their inputs and output to known 50 Ω sources and loads. Modules are typically kept small to prevent the chassis and PC board from acting as a waveguide, providing a feedback path between the input and output of a circuit, resulting in instability.

PRINTED-CIRCUIT BOARDS AT MICROWAVES

A microwave printed circuit board (PCB) is typically double-sided, with transmission-line circuitry printed on one side and a ground plane on the far side. The ground return path is best provided by plated-thru holes (PTH) connecting the two sides with minimum length. Surface-mount components — integrated circuits, chip capacitors, and chip resistors — are soldered directly to printed pads and transmission lines, and to ground pads with embedded PTH. Many of the microwave integrated circuits come in really tiny packages, with lead pitch as small as 25 mils. See the section on Surface-Mount Technology earlier in this chapter for more information on this type of construction.

When using glass-epoxy PC board at microwave frequencies, the crucial board parameter is the thickness of the dielectric. It can vary quite a bit, in excess of 10%. This is not surprising; digital and lower-frequency analog circuits work just fine if the board is a little thinner or thicker than usual. Some of the board types used in microwave-circuit

construction are a generic Teflon PC board, Duroid 5870 and 5880.

TRANSMISSION LINES AND CONNECTORS

From a mechanical accuracy point of view, the most tolerant type of construction is based on waveguide. Tuning is usually accomplished via one or more screws threaded into the waveguide. It becomes unwieldy to use waveguide on the amateur bands below 10 GHz because the dimensions get too large.

Proper connectors are a necessary expense at microwaves. At 10 GHz, the use of the proper connectors is essential for repeatable performance. Do not connect microwave circuits with coax and pigtails. It might work but it probably can't be duplicated. SMA connectors are common because they are small and work well. SMA jacks are sometimes soldered in place, although 2-56 hardware is more common.

At 24 GHz and above, even waveguide becomes small and difficult to work with. At these frequencies, most readily available coax connectors work unreliably, so these higher bands are really a challenge. Special SMA connectors are available for use at 24 GHz.

DEVICE SUBSTITUTION

It is important to copy microwave circuits exactly, unless you really know what you are doing. "Improvements," such as better shielding or grounding can sometimes cause poor performance. It isn't usually attractive to substitute components, particularly with the active devices. It may look possible to substitute different grades of the same wafer, such as the ATF13135 and the ATF13335, but these are really the same transistor with different performance measurements. While two transistors may have exactly the same gain and noise figure at the desired operating frequency, often the impedances needed to maintain stability at other frequencies can be different. Thus, the "substitute" may oscillate, while the proper transistor would work just fine.

You can often substitute MMICs (monolithic microwave integrated circuits) for one another because they are designed to be stable and operate with the same input and output impedances (50 Ω).

The size of components used at microwaves can be critical — in some cases, a chip resistor 80 mils across is not a good substitute for one 60 mils across. Hopefully, the author of a construction project tells you which dimensions are critical, but you can't always count on this; the author may not know. It's not unusual for a person to spend years building just one prototype, so it's not surprising that the author might not have built a dozen different samples to try possible substitutions.

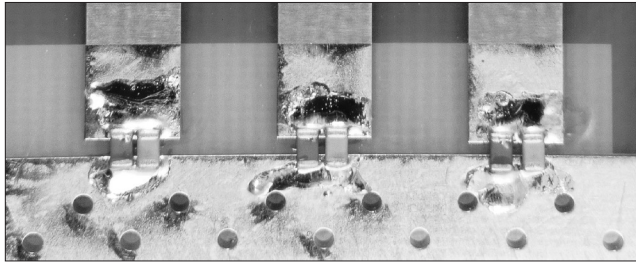


Fig 23.30 — Printed comb-line filter uses two chip capacitors in parallel to reduce loss.

23.6.4 Capacitors for Microwave Construction

Ordinary ceramic chip capacitors cost a few cents while microwave chip capacitors are more than a dollar each. All have them have parasitic resistance and inductance, but the microwave versions use lower-loss materials which make a difference at higher microwave frequencies. Ordinary ceramic capacitors work fine in non-critical applications like blocking and bypass capacitors, even up to 10 GHz. In critical areas, like low-noise or power amplifiers, microwave capacitors are preferred.

For applications requiring high-Q for low loss, like the printed comb-line filter in **Fig 23.30**, two ordinary capacitors in parallel

as shown have lower loss than one expensive microwave capacitor. By paralleling, the parasitic resistances are also paralleled, cutting the resistance in half. An additional advantage is that combinations can be chosen to yield non-standard capacitance values. We might apply this trick to really demanding applications, like high-power solid-state amplifiers, by paralleling microwave capacitors to reduce losses.

23.6.5 Tuning and “No-Tune” Designs

Microwave construction does not always require tight tolerances and precision construction. A fair amount of error can often

be tolerated if you are willing to tune your circuits, as you do at MF/HF. This usually requires the use of variable components that can be expensive and tricky to adjust.

Proper design and construction techniques, using high precision, can result in a “no-tune” microwave design. To build one of these no-tune projects, all you need do is buy the parts and install them on the board. The circuit tuning has been precisely controlled by the board and component dimensions so the project should work.

One tuning technique you can use with a microwave design, if you have the suitable test equipment, is to use bits of copper foil or EMI shielding tape as “stubs” to tune circuits. Solder these small bits of conductor into place at various points in the circuit to make reactances that can actually tune a circuit. After their position has been determined as part of the design, tuning is accomplished by removing or adding small amounts of conductor, or slightly changing the placement of the tuning stub. The size of the foil needed depends on your ability to determine changes in circuit performance, as well as the frequency of operation and the circuit board parameters. A precision setup that lets you see tiny changes allows you to use very small pieces of foil to get the best tuning possible.

23.7 Mechanical Fabrication

Most projects end up in some sort of an enclosure, and most hams choose to purchase a ready-made chassis for small projects, but some projects require a custom enclosure. Even a ready-made chassis may require a fabricated sheet-metal shield or bracket, so it's good to learn something about sheet-metal and metal-fabrication techniques.

Most often, you can buy a suitable enclosure. These are sold by RadioShack and most electronics distributors. Select an enclosure that has plenty of room. A removable cover or front panel can make any future troubleshooting or modifications easy. A project enclosure should be strong enough to hold all of the components without bending or sagging; it should also be strong enough to stand up to expected use and abuse.

23.7.1 Cutting and Bending Sheet Metal

Enclosures, mounting brackets and shields are usually made of sheet metal. Most sheet metal is sold in large sheets, 4 to 8 feet or larger. It must be cut to the size needed.

Most sheet metal is thin enough to cut with metal shears or a hacksaw. A jigsaw or band saw makes the task easier. If you use any

kind of saw, select a blade that has teeth fine enough so that at least two teeth are in contact with the metal at all times.

If a metal sheet is too large to cut conveniently with a hacksaw, it can be scored and broken. Make scratches as deep as possible along the line of the cut on both sides of the sheet. Then, clamp it in a vise and work it back and forth until the sheet breaks at the line. Do not bend it too far before the break begins to weaken, or the edge of the sheet might bend. A pair of flat bars, slightly longer than the sheet being bent, make it easier to hold a sheet firmly in a vise. Use “C” clamps to keep the bars from spreading at the ends.

Smooth rough edges with a file or by sanding with a large piece of emery cloth or sandpaper wrapped around a flat block.

Follow the directions on the container. A strong solution will do the job more rapidly.

Stir the solution with a non-metal utensil until the lye crystals are completely dissolved. If the lye solution gets on your skin, wash with plenty of water. If you get any in your eyes, immediately rinse with plenty of clean, room-temperature water and seek medical help. It can also damage your clothing, so wear something old. Prepare sufficient solution to cover the piece completely. When the aluminum is immersed, a very pronounced bubbling takes place. Provide ventilation to disperse the escaping gas. A half hour to two hours in the bath is sufficient, depending on the strength of the solution and the desired surface characteristics.

23.7.3 Chassis Working

With a few essential tools and proper procedure, building radio gear on a metal chassis is a relatively simple matter. Aluminum is better than steel, not only because it is a superior shielding material, but also because it is much easier to work and provides good chassis contact when used with secure fasteners.

Spend sufficient time planning a project to save trouble and energy later. The actual

23.7.2 Finishing Aluminum

Give aluminum chassis, panels and parts a sheen finish by treating them in a caustic bath. (See the information on chemical safety at the beginning of this chapter.) Use a plastic container to hold the solution and wear both safety goggles and protective clothing while treating aluminum. Ordinary household lye can be dissolved in water to make a bath solu-

construction is much simpler when all details are worked out beforehand. Here we discuss a large chassis-and-cabinet project, such as a high-power amplifier. The techniques are applicable to small projects as well.

Cover the top of the chassis with a piece of wrapping paper or graph paper. Fold the edges down over the sides of the chassis and fasten them with adhesive tape. Place the front panel against the chassis front and draw a line there to indicate the chassis top edge.

Assemble the parts to be mounted on the chassis top and move them about to find a satisfactory arrangement. Consider that some will be mounted underneath the chassis and ensure that the two groups of components won't interfere with each other.

Place controls with shafts that extend through the cabinet first, and arrange them so that the knobs will form the desired pattern on the panel. Position the shafts perpendicular to the front chassis edge. Locate any partition shields and panel brackets next, then sockets and any other parts. Mark the mounting-hole centers of each part accurately on the paper. Watch out for capacitors with off-center shafts that do not line up with the mounting holes. Do not forget to mark the centers of socket holes and holes for wiring leads. Make the large center hole for a socket *before* the small mounting holes. Then use the socket itself as a template to mark the centers of the mounting holes. With all chassis holes marked, center-punch and drill each hole.

Next, mount on the chassis the capacitors and any other parts with shafts extending to the panel. Fasten the front panel to the chassis temporarily. Use a machinist's square to extend the line (vertical axis) of any control shaft to the chassis front and mark the location on the front panel at the chassis line. If the layout is complex, label each mark with an identifier. Also mark the back of the front panel with the locations of any holes in the chassis front that must go through the front panel. Remove the front panel.

MAKING ENCLOSURES WITH PC BOARD MATERIAL

Much tedious sheet-metal work can be eliminated by fabricating chassis and enclosures from copper-clad printed-circuit board material. While it is manufactured in large sheets for industrial use, some hobby electronics stores and surplus outlets market usable scraps at reasonable prices. PC-board stock cuts easily with a small hacksaw. The nonmetallic base material isn't malleable, so it can't be bent. Corners are easily formed by holding two pieces at right angles and soldering the seam. This technique makes excellent RF-tight enclosures. If mechanical rigidity is required of a large copper-clad surface, solder stiffening ribs at right angles to the sheet.

Fig 23.31 shows the use of PC-board stock

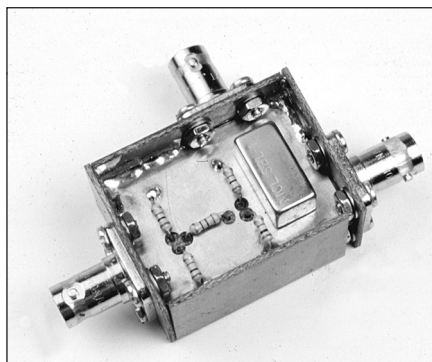


Fig 23.31 — An enclosure made entirely from PC-board stock.

to make a project enclosure. This enclosure was made by cutting the pieces to size, then soldering them together. Start by laying the bottom piece on a workbench, then placing one of the sides in place at right angles. Tack-solder the second piece in two or three places, then start at one end and run a bead of solder down the entire seam. Use plenty of solder and plenty of heat. Continue with the rest of the pieces until all but the top cover is in place.

In most cases, it is better to drill all needed holes in advance. It can sometimes be difficult to drill holes after the enclosure is soldered together.

You can use this technique to build enclosures, subassemblies or shields. This technique is easy with practice; hone your skills on a few scrap pieces of PC-board stock.

23.7.4 Drilling Techniques

Before drilling holes in metal with a hand drill, indent the hole centers with a center punch. This prevents the drill bit from “walking” away from the center when starting the hole. Predrill holes greater than 1/2 inch in diameter with a smaller bit that is large enough to contain the flat spot at the large bit's tip. When the metal being drilled is thinner than the depth of the drill-bit tip, back up the metal with a wood block to smooth the drilling process.

The chuck on the common hand drill is limited to 3/8 inch bits. Some bits are much larger, with a 3/8 inch shank. If necessary, enlarge holes with a reamer or round file. For very large or odd-shaped holes, drill a series of closely spaced small holes just inside of the desired opening. Cut the metal remaining between the holes with a cold chisel and file or grind the hole to its finished shape. A nibbling tool also works well for such holes.

Use socket-hole punches to make socket holes and other large holes in an aluminum chassis. Drill a guide hole for the punch center bolt, assemble the punch with the bolt through the guide hole and tighten the bolt

to cut the desired hole. Oil the threads of the bolt occasionally.

Cut large circular holes in steel panels or chassis with an adjustable circle cutter (“fly cutter”) in a drill press at low speed. Occasionally apply machine oil to the cutting groove to speed the job. Test the cutter's diameter setting by cutting a block of wood or scrap material first.

Remove burrs or rough edges that result from drilling or cutting with a burr-remover, round or half-round file, a sharp knife or chisel. Keep an old chisel sharpened and available for this purpose.

RECTANGULAR HOLES

Square or rectangular holes can be cut with a nibbling tool or a row of small holes as previously described. Large openings can be cut easily using socket-hole punches. A portable jig saw with the appropriate cutting blade can be used on thin sheet metal and plastic. The resulting edges will require filing.

23.7.5 Construction Notes

If a control shaft must be extended or insulated, a flexible shaft coupling with adequate insulation should be used. Satisfactory support for the shaft extension, as well as electrical contact for safety, can be provided by means of a metal panel bushing made for the purpose. These can be obtained singly for use with existing shafts, or they can be bought with a captive extension shaft included. In either case the panel bushing gives a solid feel to the control. The use of fiber washers between ceramic insulation and metal brackets, screws or nuts will prevent the ceramic parts from breaking.

PAINTING

Painting is an art, but, like most arts, successful techniques are based on skills that can be learned. The surfaces to be painted must be clean to ensure that the paint will adhere properly. In most cases, you can wash the item to be painted with soap, water and a mild scrub brush, then rinse thoroughly. When it is dry, it is ready for painting. Avoid touching it with your bare hands after it has been cleaned. Your skin oils will interfere with paint adhesion. Wear rubber or clean cotton gloves.

Sheet metal can be prepared for painting by abrading the surface with medium-grade sandpaper, making certain the strokes are applied in the same direction (not circular or random). This process will create tiny grooves on the otherwise smooth surface. As a result, paint or lacquer will adhere well. On aluminum, one or two coats of zinc chromate primer applied before the finish paint will ensure good adhesion.

Keep work areas clean and the air free

of dust. Any loose dirt or dust particles will probably find their way onto a freshly painted project. Even water-based paints produce some fumes, so properly ventilate work areas.

Select paint suitable to the task. Some paints are best for metal, others for wood and so on. Some dry quickly, with no fumes; others dry slowly and need to be thoroughly ventilated. You may want to select rust-preventative paint for metal surfaces that might be subjected to high moisture or salts.

Most metal surfaces are painted with some sort of spray, either from a spray gun or from spray cans of paint. Either way, follow the manufacturer's instructions for a high-quality job.

PANEL LAYOUT AND LABELING

There are many ways to layout and label a panel. Some builders don't label any controls or jacks, relying on memory to figure what does what. Others use a marking pen to label controls and inputs. Decals and dry transfers

have long been a staple of home brewing. Label makers that print on clear or colored tape are used by many.

With modern computers and available software, it is not hard to lay out professional looking panels. One can use a standard drawing program for the layout. The grids available on these drawing programs are sufficient to make sure that everything is lined up squarely. If the panel label is laid out before the panel is drilled for controls, a copy of the label can be used as a drill template.

Computer-aided design (CAD) programs can also be used to lay out and label panels, although they can have a steep learning curve and may be overkill for many applications.

WB8RCR has written two software programs, *Dial* and *Panel*, that are specifically designed for laying out panels and dials. There are *Windows* versions and platform independent versions available for download at www.qsl.net/wb8rcr. These programs output a Postscript file.

These programs can be used in several ways. One can print out a mirror image of the layout on a transparency and then glue that to the front panel with the printing facing towards the panel. In this manner the transparency will protect the label. The panel layout can be printed out on card stock and affixed to the front panel with spray adhesive or self-adhesive contact paper can be used. If the printing is facing outward it can be sprayed with clear acrylic spray to protect it.

Surplus meters often find their way into projects. Unfortunately the meter faces usually do not have an appropriate scale for the project at hand. Relabeling meters has long been a mainstay to make home brew gear look professional. With the advent of computers this job has been made very easy. A software package, *MeterBasic*, by Jim Tonne, W4ENE, included on the *Handbook* CD-ROM, is very easy to use and results in professional looking meters that indicate exactly what you want them to indicate.

